

## LOW-POWER, 12-BIT, 1MHz, SINGLE/DUAL UNIPOLAR INPUT, ANALOG-TO-DIGITAL CONVERTERS WITH SERIAL INTERFACE

### FEATURES

- 2.7V to 5.5V Analog Supply, Low Power:
  - 13.7mW (1MHz, +VA = 3V, +VBD = 1.8V)
- 1MHz Sampling Rate  $3V \leq +VA \leq 5.5V$ , 900kHz Sampling Rate  $2.7V \leq +VA \leq 3V$
- Excellent DC Performance:
  - $\pm 0.15\text{LSB}$  Typ,  $\pm 0.5\text{LSB}$  Max INL
  - $\pm 0.12\text{LSB}$  Typ,  $\pm 0.5\text{LSB}$  Max DNL
  - $\pm 0.8\text{mV}$  Max Offset Error at 3V
  - $\pm 1.25\text{mV}$  Max Offset Error at 5V
- Excellent AC Performance at  $f_i = 10\text{kHz}$  with 73.9dB SNR, 93.4dB SFDR,  $-88.5\text{dB}$  THD
- Built-In Conversion Clock (CCLK)
- 1.65V to 5.5V I/O Supply:
  - SPI™/DSP-Compatible Serial Interface
  - SCLK up to 50MHz
- Comprehensive Power-Down Modes:
  - Deep Power-Down
  - Nap Power-Down
  - Auto Nap Power-Down
- Unipolar Input Range: 0V to  $V_{\text{REF}}$
- Software Reset
- Global  $\overline{\text{CONVST}}$  (Independent of  $\overline{\text{CS}}$ )
- Programmable Status/Polarity EOC/ $\overline{\text{INT}}$
- 4 × 4 QFN-16 and TSSOP-16 Packages
- Multi-Chip Daisy-Chain Mode
- Programmable TAG Bit Output
- Auto/Manual Channel Select Mode (ADS7230)

### APPLICATIONS

- Communications
- Transducer Interface
- Medical Instruments
- Magnetometers
- Industrial Process Control
- Data Acquisition Systems
- Automatic Test Equipment

### DESCRIPTION

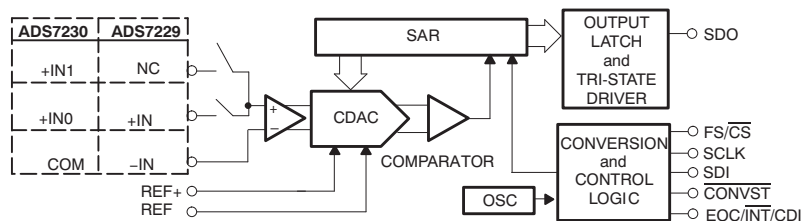
The ADS7229 is a low-power, 12-bit, 1MSPS analog-to-digital converter (ADC) with a unipolar input. The device includes a 12-bit capacitor-based successive approximation register (SAR) ADC with inherent sample-and-hold.

The ADS7230 is based on the same core and includes a 2-to-1 input MUX with a programmable TAG bit output option. Both the ADS7229 and ADS7230 offer a high-speed, wide voltage serial interface and are capable of daisy-chain mode operation when multiple converters are used.

These devices are available in 4 × 4 QFN and TSSOP-16 packages, and are fully specified for operation over the industrial  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$  temperature range.

#### Low Power, High-Speed SAR Converter Family

| Type/Speed          |        | 500 kSPS                | 1 MSPS                  |
|---------------------|--------|-------------------------|-------------------------|
| 16-bit single-ended | Single | <a href="#">ADS8327</a> | <a href="#">ADS8329</a> |
|                     | Dual   | <a href="#">ADS8328</a> | <a href="#">ADS8330</a> |
| 14-bit single-ended | Single | —                       | <a href="#">ADS7279</a> |
|                     | Dual   | —                       | <a href="#">ADS7280</a> |
| 12-bit single-ended | Single | —                       | <a href="#">ADS7229</a> |
|                     | Dual   | —                       | <a href="#">ADS7230</a> |



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This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

## ORDERING INFORMATION<sup>(1)</sup>

| MODEL    | MAXIMUM INTEGRAL LINEARITY (LSB) | MAXIMUM DIFFERENTIAL LINEARITY (LSB) | MAXIMUM OFFSET ERROR (mV) | PACKAGE TYPE | PACKAGE DESIGNATOR | TEMPERATURE RANGE | ORDERING INFORMATION | TRANSPORT MEDIA, QUANTITY |
|----------|----------------------------------|--------------------------------------|---------------------------|--------------|--------------------|-------------------|----------------------|---------------------------|
| ADS7229I | ±0.5                             | ±0.5                                 | ±1.25                     | 4 × 4 QFN-16 | RSA                | −40°C to +85°C    | ADS7229IRSAT         | Small tape and reel, 250  |
|          |                                  |                                      |                           | TSSOP-16     | PW                 |                   | ADS7229IRSAR         | Tape and reel, 3000       |
|          |                                  |                                      |                           |              |                    |                   | ADS7229IPW           | Tube, 90                  |
|          |                                  |                                      |                           |              |                    |                   | ADS7229IPWR          | Tape and reel, 2000       |
| ADS7230I | ±0.5                             | ±0.5                                 | ±1.25                     | 4 × 4 QFN-16 | RSA                | −40°C to +85°C    | ADS7230IRSAT         | Small tape and reel, 250  |
|          |                                  |                                      |                           | TSSOP-16     | PW                 |                   | ADS7230IRSAR         | Tape and reel, 3000       |
|          |                                  |                                      |                           |              |                    |                   | ADS7230IPW           | Tube, 90                  |
|          |                                  |                                      |                           |              |                    |                   | ADS7230IPWR          | Tape and reel, 2000       |

(1) For the most current package and ordering information see the Package Option Addendum at the end of this document, or see the TI web site at [www.ti.com](http://www.ti.com).

## ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>

Over operating free-air temperature range, unless otherwise noted.

|                                 |                                      | ADS7229, ADS7230                                       | UNIT |
|---------------------------------|--------------------------------------|--------------------------------------------------------|------|
| Voltage                         | +IN to AGND                          | –0.3 to +VA + 0.3                                      | V    |
|                                 | –IN to AGND                          | –0.3 to +VA + 0.3                                      | V    |
| Voltage range                   | +VA to AGND                          | –0.3 to 7                                              | V    |
|                                 | +REF to AGND                         | –0.3 to +VA + 0.3                                      | V    |
|                                 | –REF to AGND                         | –0.3 to 0.3                                            | V    |
|                                 | +VBD to BDGND                        | –0.3 to 7                                              | V    |
|                                 | AGND to BDGND                        | –0.3 to 0.3                                            | V    |
|                                 | Digital input voltage to BDGND       | –0.3 to +VBD + 0.3                                     | V    |
| Digital output voltage to BDGND |                                      | –0.3 to +VBD + 0.3                                     | V    |
| T <sub>A</sub>                  | Operating free-air temperature range | –40 to +85                                             | °C   |
| T <sub>STG</sub>                | Storage temperature range            | –65 to +150                                            | °C   |
| T <sub>J</sub><br>max           | Junction temperature                 | +150                                                   | °C   |
| 4 × 4 QFN-16 package            | Power dissipation                    | (T <sub>J</sub> max – T <sub>A</sub> )/θ <sub>JA</sub> |      |
|                                 | θ <sub>JA</sub> thermal impedance    | 47                                                     | °C/W |
| TSSOP-16 package                | Power dissipation                    | (T <sub>J</sub> max – T <sub>A</sub> )/θ <sub>JA</sub> |      |
|                                 | θ <sub>JA</sub> thermal impedance    | 86                                                     | °C/W |

(1) Stresses beyond those listed under *absolute maximum ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *recommended operating conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

## ELECTRICAL CHARACTERISTICS

At  $T_A = -40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ ,  $+V_A = 4.5\text{V}$  to  $5.5\text{V}$ ,  $+V_{BD} = +1.65\text{V}$  to  $+5.5\text{V}$ ,  $V_{REF} = 5\text{V}$ , and  $f_{\text{SAMPLE}} = 1\text{MHz}$ , unless otherwise noted.

| PARAMETER            |                                         | TEST CONDITIONS                                | ADS7229, ADS7230 |        |                  | UNIT               |
|----------------------|-----------------------------------------|------------------------------------------------|------------------|--------|------------------|--------------------|
|                      |                                         |                                                | MIN              | TYP    | MAX              |                    |
| ANALOG INPUT         |                                         |                                                |                  |        |                  |                    |
| FSR                  | Full-scale input voltage <sup>(1)</sup> | +IN – (–IN) or (+INx – COM)                    | 0                |        | V <sub>REF</sub> | V                  |
|                      | Absolute input voltage                  | +IN, +IN0, +IN1                                | AGND – 0.2       |        | +VA + 0.2        | V                  |
|                      |                                         | –IN or COM                                     | AGND – 0.2       |        | AGND + 0.2       |                    |
|                      | Input capacitance                       |                                                |                  |        | 45               | pF                 |
|                      | Input leakage current                   | No ongoing conversion, dc input                |                  | 50     |                  | nA                 |
|                      | Input channel isolation, ADS7230 only   | At dc                                          |                  | 109    |                  | dB                 |
|                      |                                         | V <sub>I</sub> = ±1.25V <sub>PP</sub> at 50kHz |                  | 101    |                  |                    |
| SYSTEM PERFORMANCE   |                                         |                                                |                  |        |                  |                    |
|                      | Resolution                              |                                                |                  | 12     |                  | Bits               |
| NMC                  | No missing codes                        |                                                | 12               |        |                  | Bits               |
| INL                  | Integral linearity                      |                                                | –0.5             | ±0.15  | 0.5              | LSB <sup>(2)</sup> |
| DNL                  | Differential linearity                  |                                                | –0.5             | ±0.12  | 0.5              | LSB <sup>(2)</sup> |
| E <sub>O</sub>       | Offset error <sup>(3)</sup>             |                                                | –1.25            | ±0.3   | 1.25             | mV                 |
|                      | Offset error drift                      | FSR = 5V                                       |                  | ±0.2   |                  | ppm/°C             |
| E <sub>G</sub>       | Gain error                              |                                                | –0.1             | ±0.002 | 0.1              | %FSR               |
|                      | Gain error drift                        |                                                |                  | ±0.5   |                  | ppm/°C             |
| CMRR                 | Common-mode rejection ratio             | At dc                                          |                  | 70     |                  | dB                 |
|                      |                                         | V <sub>I</sub> = 0.4V <sub>PP</sub> at 1MHz    |                  | 50     |                  |                    |
|                      | Noise                                   |                                                |                  | 33     |                  | μV <sub>RMS</sub>  |
| PSRR                 | Power-supply rejection ratio            | At FFFFh output code <sup>(3)</sup>            |                  | 78     |                  | dB                 |
| SAMPLING DYNAMICS    |                                         |                                                |                  |        |                  |                    |
| t <sub>CONV</sub>    | Conversion time                         |                                                |                  | 18     |                  | CCLK               |
| t <sub>SAMPLE1</sub> | Acquisition time                        | Manual trigger                                 |                  | 3      |                  | CCLK               |
| t <sub>SAMPLE2</sub> |                                         | Auto trigger                                   |                  | 3      |                  |                    |
|                      | Throughput rate                         |                                                |                  |        | 1                | MHz                |
|                      | Aperture delay                          |                                                |                  | 5      |                  | ns                 |
|                      | Aperture jitter                         |                                                |                  | 10     |                  | ps                 |
|                      | Step response                           |                                                |                  | 100    |                  | ns                 |
|                      | Overvoltage recovery                    |                                                |                  | 100    |                  | ns                 |

(1) Ideal input span; does not include gain or offset error.

(2) LSB means least significant bit.

(3) Measured relative to an ideal full-scale input [(+IN) – (–IN)] of 4.096V when +VA = 5V.

## ELECTRICAL CHARACTERISTICS (continued)

At  $T_A = -40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ ,  $+V_A = 4.5\text{V}$  to  $5.5\text{V}$ ,  $+V_{BD} = +1.65\text{V}$  to  $+5.5\text{V}$ ,  $V_{REF} = 5\text{V}$ , and  $f_{\text{SAMPLE}} = 1\text{MHz}$ , unless otherwise noted.

| PARAMETER                           |                                          |                                              | TEST CONDITIONS | ADS7229, ADS7230 |               |      | UNIT |
|-------------------------------------|------------------------------------------|----------------------------------------------|-----------------|------------------|---------------|------|------|
|                                     |                                          |                                              |                 | MIN              | TYP           | MAX  |      |
| DYNAMIC CHARACTERISTICS             |                                          |                                              |                 |                  |               |      |      |
| THD                                 | Total harmonic distortion <sup>(4)</sup> | V <sub>IN</sub> = 5V <sub>pp</sub> at 10kHz  |                 | –88.5            |               |      | dB   |
|                                     |                                          | V <sub>IN</sub> = 5V <sub>pp</sub> at 100kHz |                 | –85.5            |               |      |      |
| SNR                                 | Signal-to-noise ratio                    | V <sub>IN</sub> = 5V <sub>pp</sub> at 10kHz  |                 | 73.9             |               |      | dB   |
|                                     |                                          | V <sub>IN</sub> = 5V <sub>pp</sub> at 100kHz |                 | 72               | 73.8          |      |      |
| SINAD                               | Signal-to-noise + distortion             | V <sub>IN</sub> = 5V <sub>pp</sub> at 10kHz  |                 | 73.7             |               |      | dB   |
|                                     |                                          | V <sub>IN</sub> = 5V <sub>pp</sub> at 100kHz |                 | 73.3             |               |      |      |
| SFDR                                | Spurious-free dynamic range              | V <sub>IN</sub> = 5V <sub>pp</sub> at 10kHz  |                 | 93.4             |               |      | dB   |
|                                     |                                          | V <sub>IN</sub> = 5V <sub>pp</sub> at 100kHz |                 | 90.5             |               |      |      |
| –3dB small-signal bandwidth         |                                          |                                              |                 | 30               |               |      | MHz  |
| CLOCK                               |                                          |                                              |                 |                  |               |      |      |
| Internal conversion clock frequency |                                          |                                              |                 | 21               | 23            | 24.5 | MHz  |
| SCLK external serial clock          |                                          | Used as I/O clock only                       |                 | 50               |               |      | MHz  |
|                                     |                                          | As I/O clock and conversion clock            |                 | 1                | 42            |      |      |
| EXTERNAL VOLTAGE REFERENCE INPUT    |                                          |                                              |                 |                  |               |      |      |
| V <sub>REF</sub>                    | Input reference range                    | V <sub>REF</sub> [(REF+) – (REF–)]           |                 | 0.3              | +VA           |      | V    |
|                                     |                                          | (REF–) – AGND                                |                 | –0.1             | 0.1           |      |      |
| Resistance <sup>(5)</sup>           |                                          | Reference input                              |                 | 40               |               |      | kΩ   |
| DIGITAL INPUT/OUTPUT                |                                          |                                              |                 |                  |               |      |      |
| Logic family—CMOS                   |                                          |                                              |                 |                  |               |      |      |
| V <sub>IH</sub>                     | High-level input voltage                 | 5.5V ≥ +VBD ≥ 4.5V                           |                 | 0.65 × (+VBD)    | +VBD + 0.3    |      | V    |
| V <sub>IL</sub>                     | Low-level input voltage                  | 5.5V ≥ +VBD ≥ 4.5V                           |                 | –0.3             | 0.35 × (+VBD) |      | V    |
| I <sub>I</sub>                      | Input current                            | V <sub>I</sub> = +VBD or BDGND               |                 | –50              | 50            |      | nA   |
| C <sub>I</sub>                      | Input capacitance                        |                                              |                 | 5                |               |      | pF   |
| V <sub>OH</sub>                     | High-level output voltage                | 5.5V ≥ +VBD ≥ 4.5V, I <sub>O</sub> = 100μA   |                 | +VBD – 0.6       | +VBD          |      | V    |
| V <sub>OL</sub>                     | Low-level output voltage                 | 5.5V ≥ +VBD ≥ 4.5V, I <sub>O</sub> = 100μA   |                 | 0                | 0.4           |      | V    |
| C <sub>O</sub>                      | Output capacitance                       |                                              |                 | 5                |               |      | pF   |
| C <sub>L</sub>                      | Load capacitance                         |                                              |                 | 30               |               |      | pF   |
| Data format—straight binary         |                                          |                                              |                 |                  |               |      |      |
| POWER-SUPPLY REQUIREMENTS           |                                          |                                              |                 |                  |               |      |      |
| Power-supply voltage                | +VBD                                     |                                              |                 | 1.65             | 3.3           | 5.5  | V    |
|                                     | +VA                                      |                                              |                 | 4.5              | 5             | 5.5  | V    |
| Supply current                      | 1MHz sample rate                         |                                              | 5.7             |                  | 7.0           |      | mA   |
|                                     | Nap or Auto Nap mode                     |                                              | 0.3             |                  | 0.5           |      |      |
|                                     | Deep power-down mode                     |                                              | 4               |                  | 1             |      | μA   |
| Buffer I/O supply current           | 1MSPS, BVDD = 1.8V                       |                                              | 0.1             |                  | 0.5           |      | mA   |
|                                     | 1MSPS, BVDD = 3V                         |                                              | 0.5             |                  | 1.2           |      |      |
| Power dissipation                   | AVDD = 5V, BVDD = 1.8V                   |                                              | 28.8            |                  | 36.5          |      | mW   |
|                                     | AVDD = 5V, BVDD = 3V                     |                                              | 30.0            |                  | 38.6          |      |      |
| TEMPERATURE RANGE                   |                                          |                                              |                 |                  |               |      |      |
| T <sub>A</sub>                      | Operating free-air temperature           |                                              | –40             |                  | +85           |      | °C   |

(4) Calculated on the first nine harmonics of the input frequency.

(5) Can vary  $\pm 30\%$ .

## ELECTRICAL CHARACTERISTICS

At  $T_A = -40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ ,  $+V_A = 2.7\text{V}$  to  $3.6\text{V}$ ,  $+V_{BD} = 1.65\text{V}$  to  $1.5 \times (+V_A)$ ,  $V_{REF} = 2.5\text{V}$ ,  $f_{SAMPLE} = 1\text{MHz}$  for  $3\text{V} \leq +V_A \leq 3.6\text{V}$ , and  $f_{SAMPLE} = 900\text{kHz}$  for  $3\text{V} < +V_A \leq 2.7\text{V}$  using external clock, unless otherwise noted.

| PARAMETER            |                                         | TEST CONDITIONS                                | ADS7229, ADS7230 |        |                  | UNIT               |
|----------------------|-----------------------------------------|------------------------------------------------|------------------|--------|------------------|--------------------|
|                      |                                         |                                                | MIN              | TYP    | MAX              |                    |
| ANALOG INPUT         |                                         |                                                |                  |        |                  |                    |
| FSR                  | Full-scale input voltage <sup>(1)</sup> | +IN – (–IN) or (+INx – COM)                    | 0                |        | V <sub>REF</sub> | V                  |
|                      | Absolute input voltage                  | +IN, +IN0, +IN1                                | AGND – 0.2       |        | +VA + 0.2        | V                  |
|                      |                                         | –IN or COM                                     | AGND – 0.2       |        | AGND + 0.2       |                    |
|                      | Input capacitance                       |                                                |                  |        | 45               | pF                 |
|                      | Input leakage current                   | No ongoing conversion,<br>dc Input             |                  | 50     |                  | nA                 |
|                      | Input channel isolation, ADS7230 only   | At dc                                          |                  | 108    |                  | dB                 |
|                      |                                         | V <sub>I</sub> = ±1.25V <sub>PP</sub> at 50kHz |                  | 101    |                  |                    |
| SYSTEM PERFORMANCE   |                                         |                                                |                  |        |                  |                    |
|                      | Resolution                              |                                                |                  | 12     |                  | Bits               |
|                      | No missing codes                        |                                                |                  | 12     |                  | Bits               |
| INL                  | Integral linearity                      |                                                | –0.5             | ±0.15  | 0.5              | LSB <sup>(2)</sup> |
| DNL                  | Differential linearity                  |                                                | –0.5             | ±0.12  | 0.5              | LSB <sup>(2)</sup> |
| E <sub>O</sub>       | Offset error <sup>(3)</sup>             |                                                | –0.8             | ±0.07  | 0.8              | mV                 |
|                      | Offset error drift                      | FSR = 2.5V                                     |                  | ±0.1   |                  | ppm/°C             |
| E <sub>G</sub>       | Gain error                              |                                                | –0.1             | ±0.008 | 0.1              | %FSR               |
|                      | Gain error drift                        |                                                |                  | ±0.3   |                  | ppm/°C             |
| CMRR                 | Common-mode rejection ratio             | At dc                                          |                  | 70     |                  | dB                 |
|                      |                                         | V <sub>I</sub> = 0.4V <sub>PP</sub> at 1MHz    |                  | 50     |                  |                    |
|                      | Noise                                   |                                                |                  | 33     |                  | μV <sub>RMS</sub>  |
| PSRR                 | Power-supply rejection ratio            | At FFFFh output code <sup>(3)</sup>            |                  | 78     |                  | dB                 |
| SAMPLING DYNAMICS    |                                         |                                                |                  |        |                  |                    |
| t <sub>CONV</sub>    | Conversion time                         |                                                |                  | 18     |                  | CCLK               |
| t <sub>SAMPLE1</sub> | Acquisition time                        | Manual trigger                                 | 3                |        |                  | CCLK               |
| t <sub>SAMPLE2</sub> |                                         | Auto trigger                                   |                  | 3      |                  |                    |
|                      | Throughput rate                         | 2.7V ≤ +VA < 3.0V                              |                  |        | 0.9              | MHz                |
|                      |                                         | 3.0V ≤ +VA ≤ 3.64V                             |                  |        | 1                |                    |
|                      | Aperture delay                          |                                                |                  | 5      |                  | ns                 |
|                      | Aperture jitter                         |                                                |                  | 10     |                  | ps                 |
|                      | Step response                           |                                                |                  | 100    |                  | ns                 |
|                      | Overvoltage recovery                    |                                                |                  | 100    |                  | ns                 |

(1) Ideal input span; does not include gain or offset error.

(2) LSB means least significant bit.

(3) Measured relative to an ideal full-scale input [(+IN) – (–IN)] of 2.5V when  $+V_A = 3\text{V}$ .

## ELECTRICAL CHARACTERISTICS (continued)

At  $T_A = -40^\circ\text{C}$  to  $+85^\circ\text{C}$ ,  $+V_A = 2.7\text{V}$  to  $3.6\text{V}$ ,  $+V_{BD} = 1.65\text{V}$  to  $1.5 \times (+V_A)$ ,  $V_{REF} = 2.5\text{V}$ ,  $f_{SAMPLE} = 1\text{MHz}$  for  $3\text{V} \leq +V_A \leq 3.6\text{V}$ , and  $f_{SAMPLE} = 900\text{kHz}$  for  $3\text{V} < +V_A \leq 2.7\text{V}$  using external clock, unless otherwise noted.

| PARAMETER                           |                                          | TEST CONDITIONS                                     | ADS7229, ADS7230 |               |      | UNIT |     |
|-------------------------------------|------------------------------------------|-----------------------------------------------------|------------------|---------------|------|------|-----|
|                                     |                                          |                                                     | MIN              | TYP           | MAX  |      |     |
| DYNAMIC CHARACTERISTICS             |                                          |                                                     |                  |               |      |      |     |
| THD                                 | Total harmonic distortion <sup>(4)</sup> | V <sub>IN</sub> = 2.5V <sub>PP</sub> at 10kHz       | –96.8            |               |      | dB   |     |
|                                     |                                          | V <sub>IN</sub> = 2.5V <sub>PP</sub> at 100kHz      | –88.4            |               |      |      |     |
| SNR                                 | Signal-to-noise ratio                    | V <sub>IN</sub> = 2.5V <sub>PP</sub> at 10kHz       | 72               | 73.2          | dB   |      |     |
|                                     |                                          | V <sub>IN</sub> = 2.5V <sub>PP</sub> at 100kHz      | 72               |               |      |      |     |
| SINAD                               | Signal-to-noise + distortion             | V <sub>IN</sub> = 2.5V <sub>PP</sub> at 10kHz       | 73.1             |               |      | dB   |     |
|                                     |                                          | V <sub>IN</sub> = 2.5V <sub>PP</sub> at 100kHz      | 72.1             |               |      |      |     |
| SFDR                                | Spurious-free dynamic range              | V <sub>IN</sub> = 2.5V <sub>PP</sub> at 10kHz       | 95.9             |               |      | dB   |     |
|                                     |                                          | V <sub>IN</sub> = 2.5V <sub>PP</sub> at 100kHz      | 91.5             |               |      |      |     |
| –3dB small-signal bandwidth         |                                          |                                                     | 30               |               |      | MHz  |     |
| CLOCK                               |                                          |                                                     |                  |               |      |      |     |
| Internal conversion clock frequency |                                          |                                                     | 21               | 23            | 23.5 | MHz  |     |
| SCLK external serial clock          |                                          | Used as I/O clock only                              |                  |               |      | 42   | MHz |
|                                     |                                          | As I/O clock and conversion clock                   | 1                |               |      | 42   |     |
| EXTERNAL VOLTAGE REFERENCE INPUT    |                                          |                                                     |                  |               |      |      |     |
| V <sub>REF</sub>                    | Input reference range                    | f <sub>SAMPLE</sub> ≤ 500kSPS, 2.7V ≤ +VA < 3V      | 0.3              | 2.525         |      | V    |     |
|                                     |                                          | f <sub>SAMPLE</sub> ≤ 500kSPS, 3V ≤ +VA < 3.6V      | 0.3              | 3             |      |      |     |
|                                     |                                          | f <sub>SAMPLE</sub> > 500kSPS, 2.7V ≤ +VA < 3V      | 2.475            | 2.525         |      |      |     |
|                                     |                                          | f <sub>SAMPLE</sub> > 500kSPS, 3V ≤ +VA ≤ 3.6V      | 2.475            | 3             |      |      |     |
|                                     |                                          | (REF–) – AGND                                       |                  | –0.1          | 0.1  |      |     |
| Resistance <sup>(5)</sup>           |                                          | Reference input                                     | 40               |               |      | kΩ   |     |
| DIGITAL INPUT/OUTPUT                |                                          |                                                     |                  |               |      |      |     |
| Logic family—CMOS                   |                                          |                                                     |                  |               |      |      |     |
| V <sub>IH</sub>                     | High-level input voltage                 | (+VA × 1.5)V ≥ +VBD ≥ 1.65V                         | 0.65 × (+VBD)    | +VBD + 0.3    |      | V    |     |
| V <sub>IL</sub>                     | Low-level input voltage                  | (+VA × 1.5)V ≥ +VBD ≥ 1.65V                         | –0.3             | 0.35 × (+VBD) |      | V    |     |
| I <sub>I</sub>                      | Input current                            | V <sub>I</sub> = +VBD or BDGND                      | –50              | 50            |      | nA   |     |
| C <sub>I</sub>                      | Input capacitance                        |                                                     | 5                |               |      | pF   |     |
| V <sub>OH</sub>                     | High-level output voltage                | (+VA × 1.5)V ≥ +VBD ≥ 1.65V, I <sub>O</sub> = 100μA | +VBD – 0.6       | +VBD          |      | V    |     |
| V <sub>OL</sub>                     | Low-level output voltage                 | (+VA × 1.5)V ≥ +VBD ≥ 1.65V, I <sub>O</sub> = 100μA | 0                | 0.4           |      | V    |     |
| C <sub>O</sub>                      | Output capacitance                       |                                                     | 5                |               |      | pF   |     |
| C <sub>L</sub>                      | Load capacitance                         |                                                     | 30               |               |      | pF   |     |
| Data format—straight binary         |                                          |                                                     |                  |               |      |      |     |

(4) Calculated on the first nine harmonics of the input frequency.

(5) Can vary  $\pm 30\%$ .

## ELECTRICAL CHARACTERISTICS (continued)

At  $T_A = -40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ ,  $+VA = 2.7\text{V}$  to  $3.6\text{V}$ ,  $+VBD = 1.65\text{V}$  to  $1.5 \times (+VA)$ ,  $V_{REF} = 2.5\text{V}$ ,  $f_{SAMPLE} = 1\text{MHz}$  for  $3\text{V} \leq +VA \leq 3.6\text{V}$ , and  $f_{SAMPLE} = 900\text{kHz}$  for  $3\text{V} < +VA \leq 2.7\text{V}$  using external clock, unless otherwise noted.

| PARAMETER                 |                                | TEST CONDITIONS                        | ADS7229, ADS7230 |       |             | UNIT |
|---------------------------|--------------------------------|----------------------------------------|------------------|-------|-------------|------|
|                           |                                |                                        | MIN              | TYP   | MAX         |      |
| POWER-SUPPLY REQUIREMENTS |                                |                                        |                  |       |             |      |
| Power-supply voltage      | +VBD                           |                                        | 1.65             | +VA   | 1.5 × (+VA) | V    |
|                           | +VA                            | f <sub>s</sub> ≤ 1MHz                  | 3                |       | 3.6         | V    |
|                           |                                | f <sub>s</sub> ≤ 900kHz                | 2.7              |       | 3.6         |      |
| Supply current            |                                | 1MHz sample rate,<br>3V ≤ +VA ≤ 3.6V   |                  | 4.5   | 6.0         | mA   |
|                           |                                | 900kHz sample rate,<br>2.7V ≤ +VA ≤ 3V |                  | 4.2   |             |      |
|                           |                                | Nap or Auto Nap mode                   |                  | 0.25  | 0.4         |      |
|                           |                                | Deep power-down mode                   |                  | 0.001 | 1           | μA   |
| Buffer I/O supply current |                                | 1MSPS, BVDD = 1.8V                     |                  | 0.1   | 0.5         | mA   |
|                           |                                | 1MSPS, BVDD = 3V                       |                  | 0.5   | 1.2         |      |
| Power dissipation         |                                | AVDD = 3V, BVDD = 1.8V                 |                  | 13.7  | 18.9        | mW   |
|                           |                                | AVDD = 3V, BVDD = 3V                   |                  | 15.0  | 21.6        |      |
| TEMPERATURE RANGE         |                                |                                        |                  |       |             |      |
| T <sub>A</sub>            | Operating free-air temperature |                                        | −40              |       | +85         | °C   |

## TIMING CHARACTERISTICS<sup>(1)(2)</sup>: 5V

All specifications typical at –40°C to +85°C and +VA = +VBD = 5V, unless otherwise noted.

| PARAMETER          |                                                                                        |                                                        | ADS7229, ADS7230 |     |                       | UNIT |
|--------------------|----------------------------------------------------------------------------------------|--------------------------------------------------------|------------------|-----|-----------------------|------|
|                    |                                                                                        |                                                        | MIN              | TYP | MAX                   |      |
| f <sub>CCLK</sub>  | Frequency, conversion clock, CCLK                                                      | External,<br>f <sub>CCLK</sub> = 1/2 f <sub>SCLK</sub> | 0.5              |     | 21                    | MHz  |
|                    |                                                                                        | Internal,<br>f <sub>CCLK</sub> = 1/2 f <sub>SCLK</sub> | 21               | 23  | 24.5                  |      |
| t <sub>1</sub>     | Setup time, falling edge of $\overline{\text{CS}}$ to EOC                              |                                                        | 1                |     |                       | CCLK |
| t <sub>2</sub>     | Hold time, falling edge of $\overline{\text{CS}}$ to EOC                               |                                                        | 0                |     |                       | ns   |
| t <sub>CL</sub>    | Pulse duration, $\overline{\text{CONVST}}$ low                                         |                                                        | 40               |     |                       | ns   |
| t <sub>3</sub>     | Hold time, falling edge of $\overline{\text{CS}}$ to EOS                               |                                                        | 20               |     |                       | ns   |
| t <sub>4</sub>     | Setup time, rising edge of $\overline{\text{CS}}$ to EOS                               |                                                        | 20               |     |                       | ns   |
| t <sub>5</sub>     | Hold time, rising edge of $\overline{\text{CS}}$ to EOS                                |                                                        | 20               |     |                       | ns   |
| t <sub>6</sub>     | Setup time, falling edge of $\overline{\text{CS}}$ to first falling SCLK               |                                                        | 5                |     |                       | ns   |
| t <sub>SCLKL</sub> | Pulse duration, SCLK low                                                               |                                                        | 8                |     | t <sub>SCLK</sub> – 8 | ns   |
| t <sub>SCLKH</sub> | Pulse duration, SCLK high                                                              |                                                        | 8                |     | t <sub>SCLK</sub> – 8 | ns   |
| t <sub>SCLK</sub>  | Cycle time, SCLK                                                                       | I/O clock only                                         | 20               |     |                       | ns   |
|                    |                                                                                        | I/O and conversion clock                               | 23.8             |     | 2000                  |      |
|                    |                                                                                        | I/O clock, chain mode                                  | 20               |     |                       |      |
|                    |                                                                                        | I/O and conversion clock, chain mode                   | 23.8             |     | 2000                  |      |
| t <sub>H2</sub>    | Hold time, falling edge of SCLK to SDO invalid                                         | 10pF load                                              | 2                |     |                       | ns   |
| t <sub>D1</sub>    | Delay time, falling edge of SCLK to SDO valid                                          | 10pF load                                              |                  |     | 10                    | ns   |
| t <sub>D2</sub>    | Delay time, falling edge of $\overline{\text{CS}}$ to SDO valid, SDO MSB output        | 10pF load                                              |                  |     | 8.5                   | ns   |
| t <sub>S1</sub>    | Setup time, SDI to falling edge of SCLK                                                |                                                        | 8                |     |                       | ns   |
| t <sub>H1</sub>    | Hold time, SDI to falling edge of SCLK                                                 |                                                        | 4                |     |                       | ns   |
| t <sub>D3</sub>    | Delay time, rising edge of $\overline{\text{CS}}$ /FS to SDO t <sub>D3</sub> 3-state   |                                                        |                  |     | 5                     | ns   |
| t <sub>7</sub>     | Setup time, 16th falling edge of SCLK before rising edge of $\overline{\text{CS}}$ /FS |                                                        | 10               |     |                       | ns   |

(1) All input signals are specified with t<sub>r</sub> = t<sub>f</sub> = 1.5ns (10% to 90% of VBD) and timed from a voltage level of (V<sub>IL</sub> + V<sub>IH</sub>)/2.

(2) See timing diagrams.

## TIMING CHARACTERISTICS<sup>(1)(2)</sup>: 1.8V

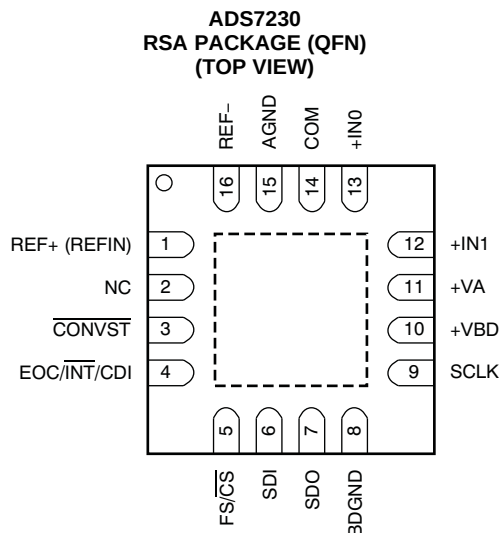
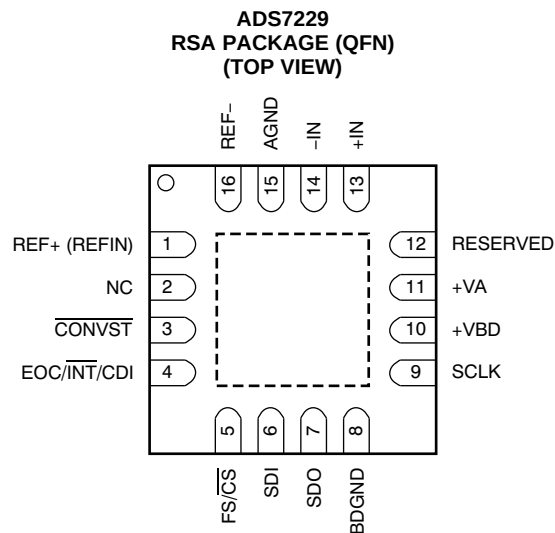
All specifications typical at –40°C to 85°C, +VA = 2.7 V, and +VBD = 1.8V, unless otherwise noted.

| PARAMETER          |                                                                                               | ADS7229, ADS7230                                                        |                       |              | UNIT |
|--------------------|-----------------------------------------------------------------------------------------------|-------------------------------------------------------------------------|-----------------------|--------------|------|
|                    |                                                                                               | MIN                                                                     | TYP                   | MAX          |      |
| f <sub>CCLK</sub>  | Frequency, conversion clock, CCLK                                                             | External, 3V ≤ +VA ≤ 3.6V,<br>f <sub>CCLK</sub> = 1/2 f <sub>SCLK</sub> |                       | 21           | MHz  |
|                    |                                                                                               | External, 2.7V ≤ +VA ≤ 3V,<br>f <sub>CCLK</sub> = 1/2 f <sub>SCLK</sub> |                       | 18.9         |      |
|                    |                                                                                               | Internal,<br>f <sub>CCLK</sub> = 1/2 f <sub>SCLK</sub>                  |                       | 20 22.3 23.5 |      |
| t <sub>1</sub>     | Setup time, falling edge of $\overline{CS}$ to EOC                                            | 1                                                                       |                       |              | CCLK |
| t <sub>2</sub>     | Hold time, falling edge of $\overline{CS}$ to EOC                                             | 0                                                                       |                       |              | ns   |
| t <sub>CL</sub>    | Pulse duration, $\overline{CONVST}$ low                                                       | 40                                                                      |                       |              | ns   |
| t <sub>3</sub>     | Hold time, falling edge of $\overline{CS}$ to EOS                                             | 20                                                                      |                       |              | ns   |
| t <sub>4</sub>     | Setup time, rising edge of $\overline{CS}$ to EOS                                             | 20                                                                      |                       |              | ns   |
| t <sub>5</sub>     | Hold time, rising edge of $\overline{CS}$ to EOS                                              | 20                                                                      |                       |              | ns   |
| t <sub>6</sub>     | Setup time, falling edge of $\overline{CS}$ to first t <sub>6</sub> falling SCLK              | 5                                                                       |                       |              | ns   |
| t <sub>SCLKL</sub> | Pulse duration, SCLK low                                                                      | 8                                                                       | t <sub>SCLK</sub> – 8 |              | ns   |
| t <sub>SCLKH</sub> | Pulse duration, SCLK high                                                                     | 8                                                                       | t <sub>SCLK</sub> – 8 |              | ns   |
| t <sub>SCLK</sub>  | Cycle time, SCLK                                                                              | All modes,<br>3V ≤ +VA ≤ 3.6V                                           |                       | 2000         | ns   |
|                    |                                                                                               | All modes,<br>2.7V ≤ +VA < 3V                                           |                       | 26.5         |      |
| t <sub>H2</sub>    | Hold time, falling edge of SCLK to SDO invalid                                                | 10pF load                                                               |                       | 7.5          | ns   |
| t <sub>D1</sub>    | Delay time, falling edge of SCLK to SDO valid                                                 | 10pF load                                                               |                       | 16           | ns   |
| t <sub>D2</sub>    | Delay time, falling edge of $\overline{CS}$ to SDO valid, SDO MSB output                      | 10pF load,<br>2.7V ≤ +VA ≤ 3V                                           |                       | 13           | ns   |
|                    |                                                                                               | 10pF load,<br>3V ≤ +VA ≤ 3.6V                                           |                       | 11           |      |
| t <sub>S1</sub>    | Setup time, SDI to falling edge of SCLK                                                       | 8                                                                       |                       |              | ns   |
| t <sub>H1</sub>    | Hold time, SDI to falling edge of SCLK                                                        | 4                                                                       |                       |              | ns   |
| t <sub>D3</sub>    | Delay time, rising edge of $\overline{CS}/FS$ to SDO 3-state                                  | 8                                                                       |                       |              | ns   |
| t <sub>7</sub>     | Setup time, 16th falling edge of SCLK t <sub>7</sub> before rising edge of $\overline{CS}/FS$ | 10                                                                      |                       |              | ns   |

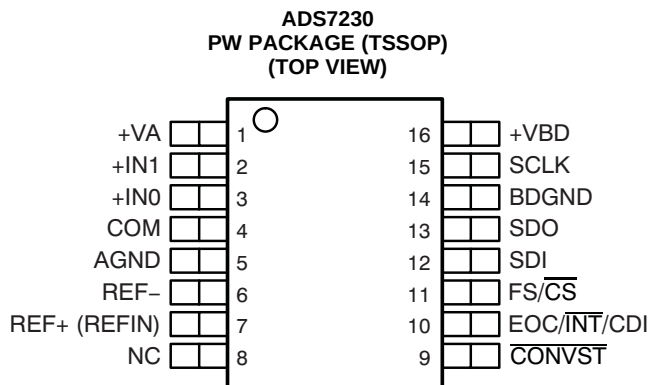
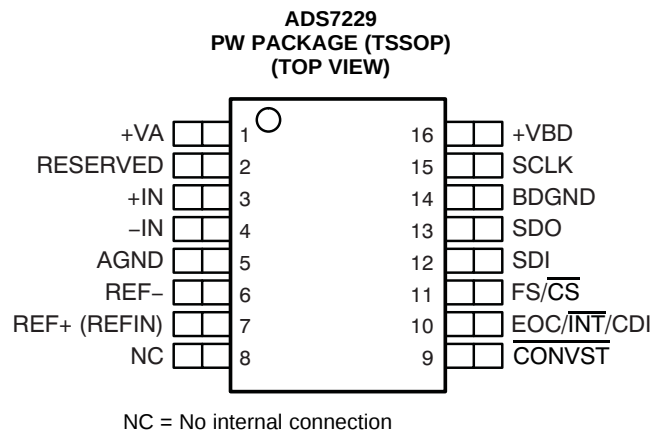
(1) All input signals are specified with t<sub>r</sub> = t<sub>f</sub> = 1.5ns (10% to 90% of VBD) and timed from a voltage level of (V<sub>IL</sub> + V<sub>IH</sub>)/2.

(2) See timing diagrams.

## PIN ASSIGNMENTS



**CAUTION:** The thermal pad is internally connected to the substrate. This pad can be connected to the analog ground or left floating. Keep the thermal pad separate from the digital ground, if possible.



**ADS7229 Terminal Functions**

| NAME                              | NO. |       | I/O | DESCRIPTION                                                                                                                                                                                                                                                                                                                                                                                  |
|-----------------------------------|-----|-------|-----|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|                                   | QFN | TSSOP |     |                                                                                                                                                                                                                                                                                                                                                                                              |
| AGND                              | 15  | 5     | —   | Analog ground                                                                                                                                                                                                                                                                                                                                                                                |
| BDGND                             | 8   | 14    | —   | Interface ground                                                                                                                                                                                                                                                                                                                                                                             |
| CONVST                            | 3   | 9     | I   | Freezes sample-and-hold, starts conversion with next rising edge of internal clock                                                                                                                                                                                                                                                                                                           |
| EOC/ $\overline{\text{INT}}$ /CDI | 4   | 10    | I/O | Status output. If programmed as EOC, this pin is low (default) when a conversion is in progress. If programmed as an interrupt (INT), this pin is low for a preprogrammed duration after the end of conversion and valid data are to be output. The polarity of EOC or INT is programmable. This pin can also be used as a chain data input when the device is operated in daisy-chain mode. |
| FS/ $\overline{\text{CS}}$        | 5   | 11    | I   | Frame sync signal for TMS320 DSP serial interface or chip select input for SPI interface slave select (SS–).                                                                                                                                                                                                                                                                                 |
| +IN                               | 13  | 3     | I   | Noninverting input                                                                                                                                                                                                                                                                                                                                                                           |
| –IN                               | 14  | 4     | I   | Inverting input; usually connected to ground                                                                                                                                                                                                                                                                                                                                                 |
| NC                                | 2   | 8     | —   | No connection                                                                                                                                                                                                                                                                                                                                                                                |
| REF+ (REFIN)                      | 1   | 7     | I   | External reference input                                                                                                                                                                                                                                                                                                                                                                     |
| REF–                              | 16  | 6     | I   | Connect to AGND through individual via                                                                                                                                                                                                                                                                                                                                                       |
| RESERVED                          | 12  | 2     | I   | Connect to AGND or +VA                                                                                                                                                                                                                                                                                                                                                                       |
| SCLK                              | 9   | 15    | I   | Clock for serial interface                                                                                                                                                                                                                                                                                                                                                                   |
| SDI                               | 6   | 12    | I   | Serial data in                                                                                                                                                                                                                                                                                                                                                                               |
| SDO                               | 7   | 13    | O   | Serial data out                                                                                                                                                                                                                                                                                                                                                                              |
| +VA                               | 11  | 1     |     | Analog supply, +2.7V to +5.5VDC                                                                                                                                                                                                                                                                                                                                                              |
| +VBD                              | 10  | 16    |     | Interface supply                                                                                                                                                                                                                                                                                                                                                                             |

**ADS7230 Terminal Functions**

| NAME                              | NO. |       | I/O | DESCRIPTION                                                                                                                                                                                                                                                                                                                                                                                  |
|-----------------------------------|-----|-------|-----|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|                                   | QFN | TSSOP |     |                                                                                                                                                                                                                                                                                                                                                                                              |
| AGND                              | 15  | 5     | —   | Analog ground                                                                                                                                                                                                                                                                                                                                                                                |
| BDGND                             | 8   | 14    | —   | Interface ground                                                                                                                                                                                                                                                                                                                                                                             |
| COM                               | 14  | 4     | I   | Common inverting input; usually connected to ground                                                                                                                                                                                                                                                                                                                                          |
| CONVST                            | 3   | 9     | I   | Freezes sample-and-hold, starts conversion with next rising edge of internal clock                                                                                                                                                                                                                                                                                                           |
| EOC/ $\overline{\text{INT}}$ /CDI | 4   | 10    | I/O | Status output. If programmed as EOC, this pin is low (default) when a conversion is in progress. If programmed as an interrupt (INT), this pin is low for a preprogrammed duration after the end of conversion and valid data are to be output. The polarity of EOC or INT is programmable. This pin can also be used as a chain data input when the device is operated in daisy-chain mode. |
| FS/ $\overline{\text{CS}}$        | 5   | 11    | I   | Frame sync signal for TMS320 DSP serial interface or chip select input for SPI interface                                                                                                                                                                                                                                                                                                     |
| +IN1                              | 12  | 2     | I   | Second noninverting input                                                                                                                                                                                                                                                                                                                                                                    |
| +IN0                              | 13  | 3     | I   | First noninverting input                                                                                                                                                                                                                                                                                                                                                                     |
| NC                                | 2   | 8     | —   | No connection.                                                                                                                                                                                                                                                                                                                                                                               |
| REF+ (REFIN)                      | 1   | 7     | I   | External reference input                                                                                                                                                                                                                                                                                                                                                                     |
| REF–                              | 16  | 6     | I   | Connect to AGND through individual via                                                                                                                                                                                                                                                                                                                                                       |
| SCLK                              | 9   | 15    | I   | Clock for serial interface                                                                                                                                                                                                                                                                                                                                                                   |
| SDI                               | 6   | 12    | I   | Serial data in (conversion start and reset possible)                                                                                                                                                                                                                                                                                                                                         |
| SDO                               | 7   | 13    | O   | Serial data out                                                                                                                                                                                                                                                                                                                                                                              |
| +VA                               | 11  | 1     |     | Analog supply, +2.7V to +5.5VDC                                                                                                                                                                                                                                                                                                                                                              |
| +VBD                              | 10  | 16    |     | Interface supply                                                                                                                                                                                                                                                                                                                                                                             |

MANUAL TRIGGER/READ While Sampling  
(use internal CCLK, EOC, and INT polarity programmed as active low)

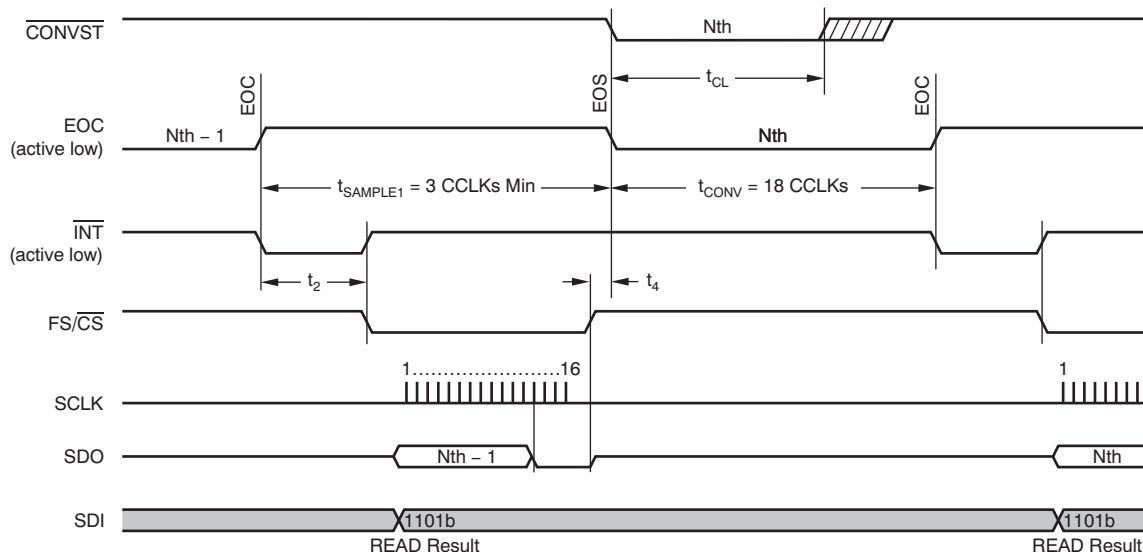


Figure 1. Timing for Conversion and Acquisition Cycles for Manual Trigger (Read While Sampling)

MANUAL TRIGGER/READ While Converting  
(use internal CCLK, EOC, and INT polarity programmed as active low)

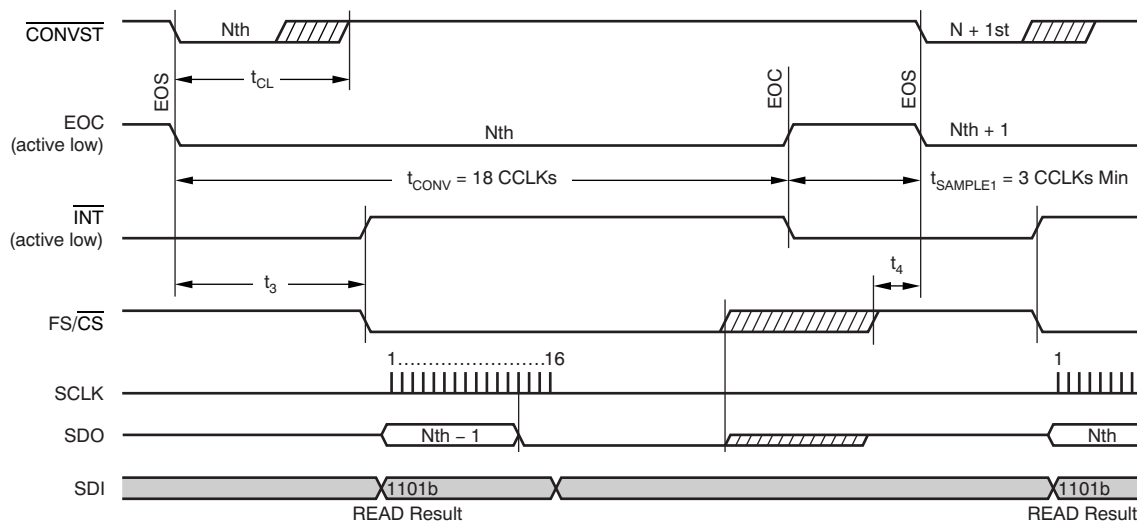
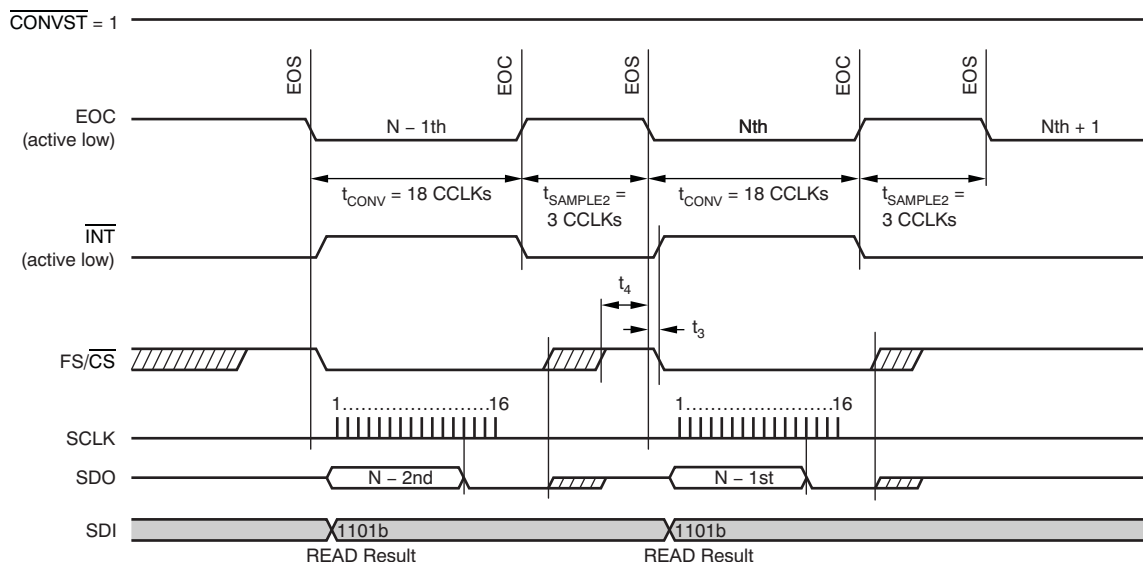
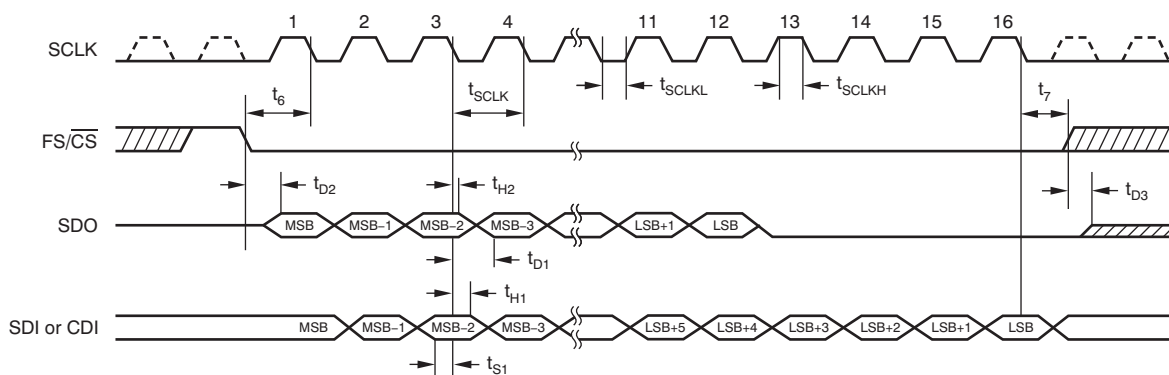


Figure 2. Timing for Conversion and Acquisition Cycles for Manual Trigger (Read While Converting)

AUTO TRIGGER/READ While Converting  
(use internal CCLK, EOC, and INT polarity programmed as active low)



**Figure 3. Timing for Conversion and Acquisition Cycles for Autotrigger (Read While Converting)**



**Figure 4. Detailed SPI Transfer Timing**

MANUAL TRIGGER/READ While Converting

(use internal CCLK, EOC, and INT polarity programmed as active low, TAG enabled, auto channel select)

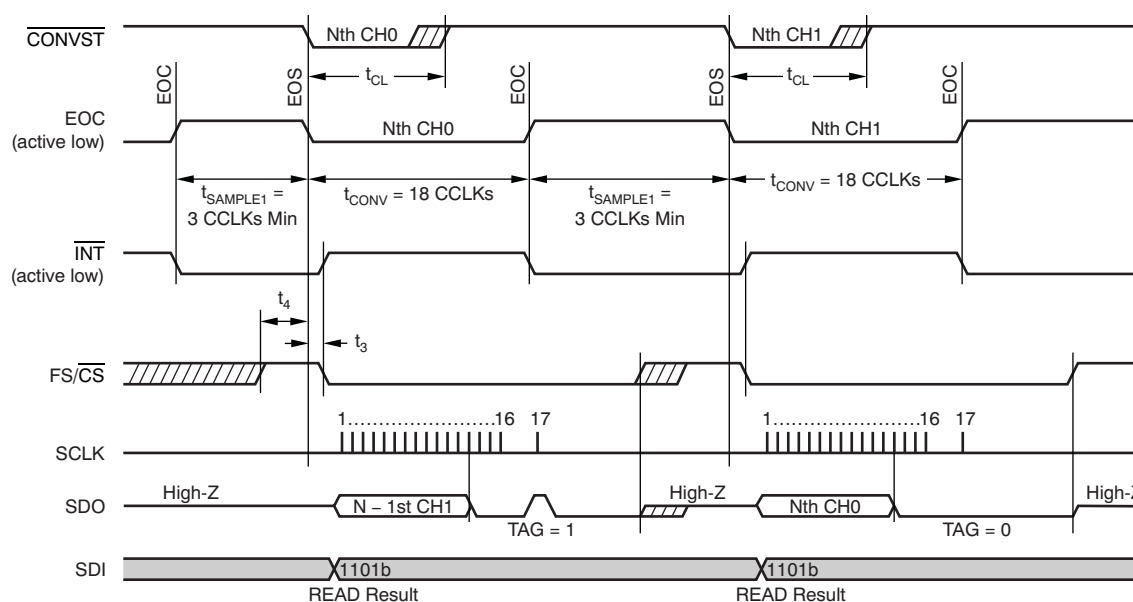


Figure 5. Simplified Dual Channel Timing

## TYPICAL CHARACTERISTICS

At  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ ,  $V_{\text{REF}} [(\text{REF}+) - (\text{REF}-)] = 5\text{V}$  when  $+V_A = +V_{\text{BD}} = 5\text{V}$  or  $V_{\text{REF}} [(\text{REF}+) - (\text{REF}-)] = 2.5\text{V}$  when  $+V_A = +V_{\text{BD}} = 3\text{V}$ ,  $f_{\text{SCLK}} = 42\text{MHz}$ , or  $V_{\text{REF}} = 2.5$  when  $+V_A = +V_{\text{BD}} = 2.7\text{V}$ ,  $f_{\text{SCLK}} = 37.8\text{MHz}$ , and  $f_i = \text{dc}$  for dc curves,  $f_i = 100\text{kHz}$  for ac curves with  $5\text{V}$  supply, and  $f_i = 10\text{kHz}$  for ac curves with  $3\text{V}$  supply, unless otherwise noted.

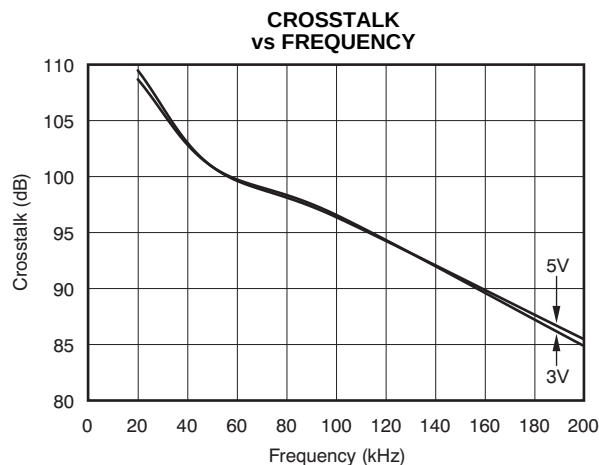


Figure 6.

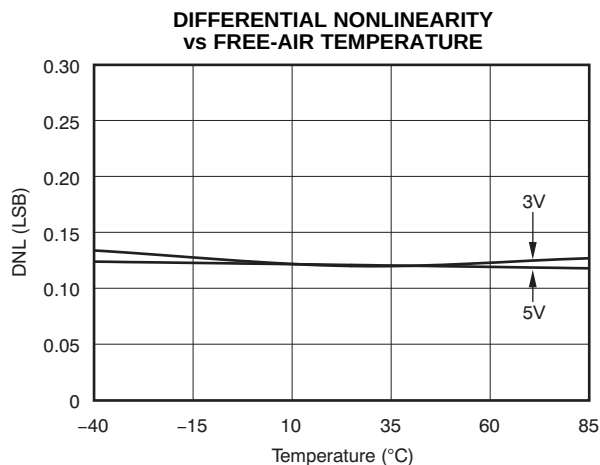


Figure 7.

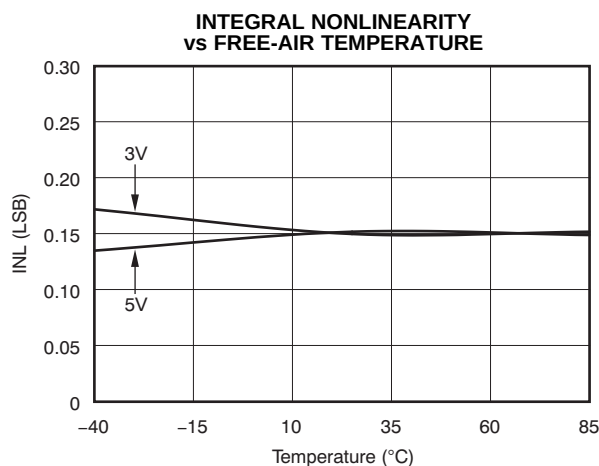


Figure 8.

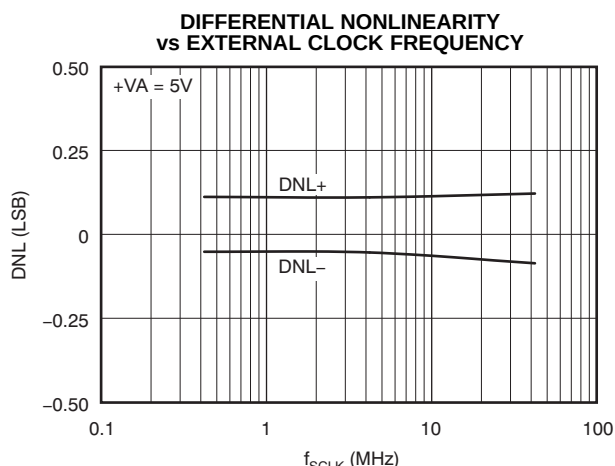


Figure 9.

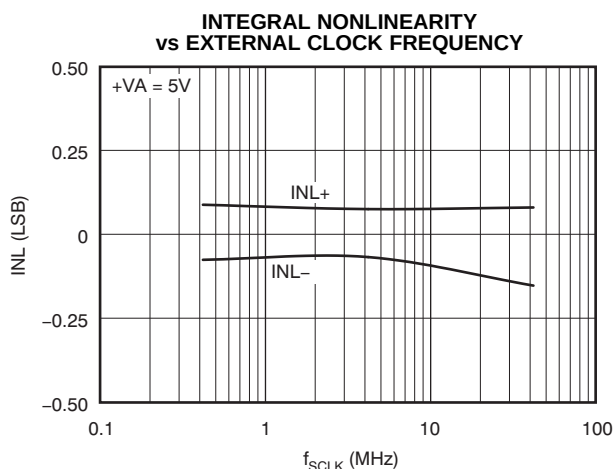


Figure 10.

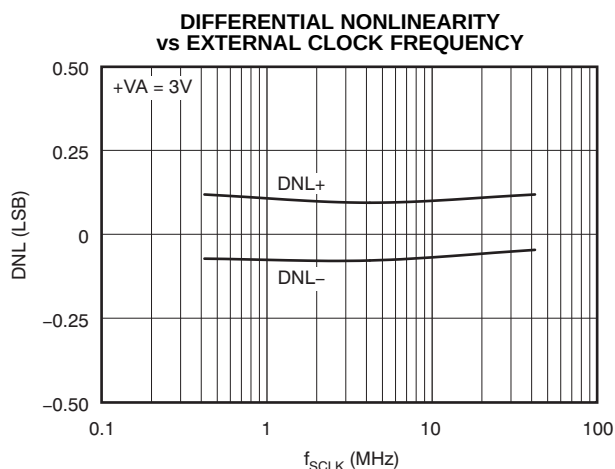


Figure 11.

## TYPICAL CHARACTERISTICS (continued)

At  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ ,  $V_{\text{REF}}[(\text{REF}+) - (\text{REF}-)] = 5\text{V}$  when  $+V_A = +V_{\text{BD}} = 5\text{V}$  or  $V_{\text{REF}}[(\text{REF}+) - (\text{REF}-)] = 2.5\text{V}$  when  $+V_A = +V_{\text{BD}} = 3\text{V}$ ,  $f_{\text{SCLK}} = 42\text{MHz}$ , or  $V_{\text{REF}} = 2.5$  when  $+V_A = +V_{\text{BD}} = 2.7\text{V}$ ,  $f_{\text{SCLK}} = 37.8\text{MHz}$ , and  $f_i = \text{dc}$  for dc curves,  $f_i = 100\text{kHz}$  for ac curves with  $5\text{V}$  supply, and  $f_i = 10\text{kHz}$  for ac curves with  $3\text{V}$  supply, unless otherwise noted.

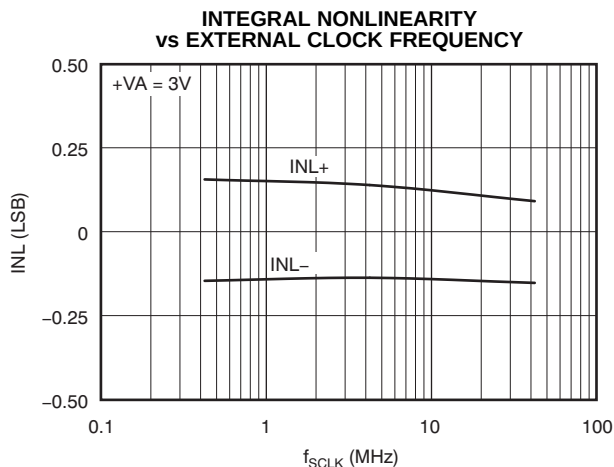


Figure 12.

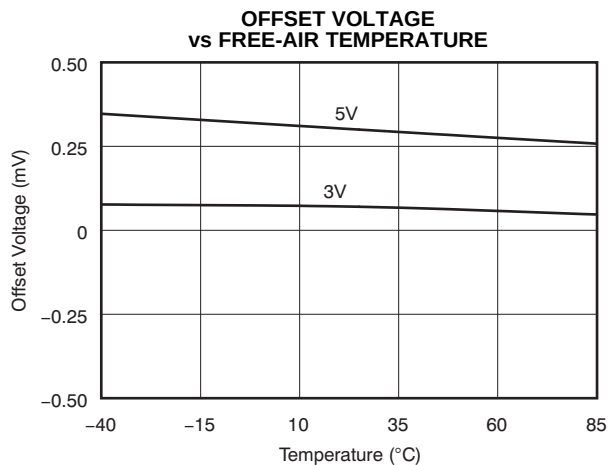


Figure 13.

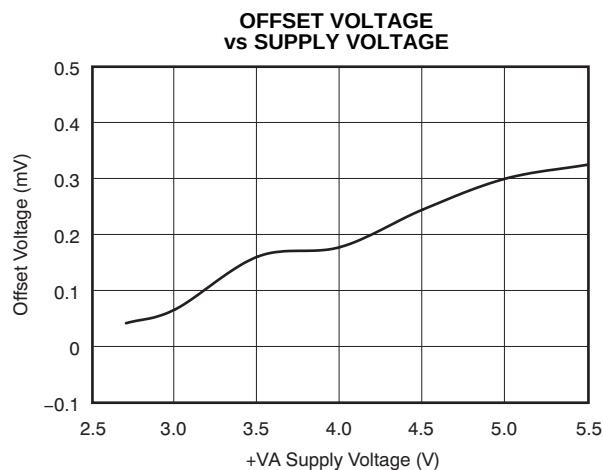


Figure 14.

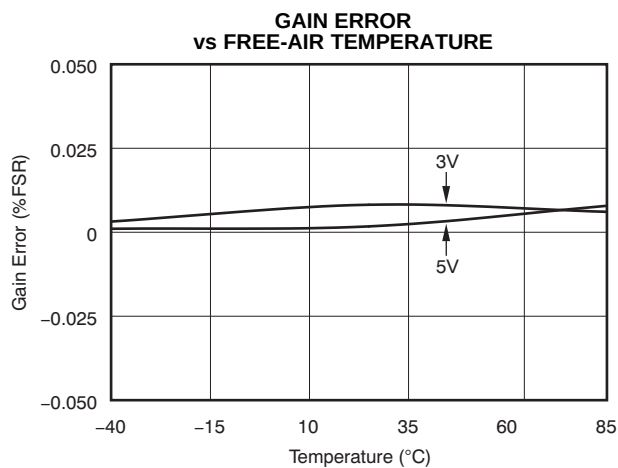


Figure 15.

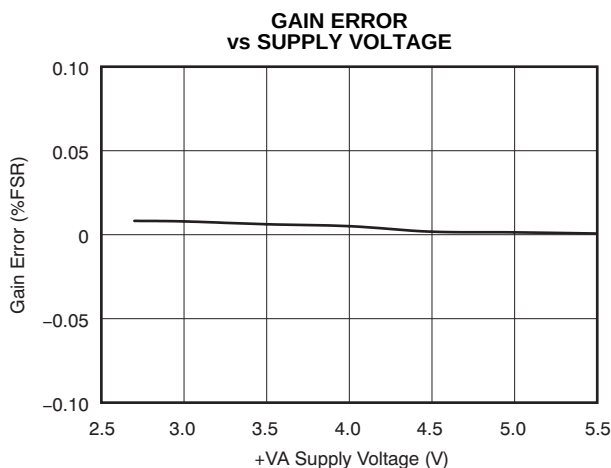


Figure 16.

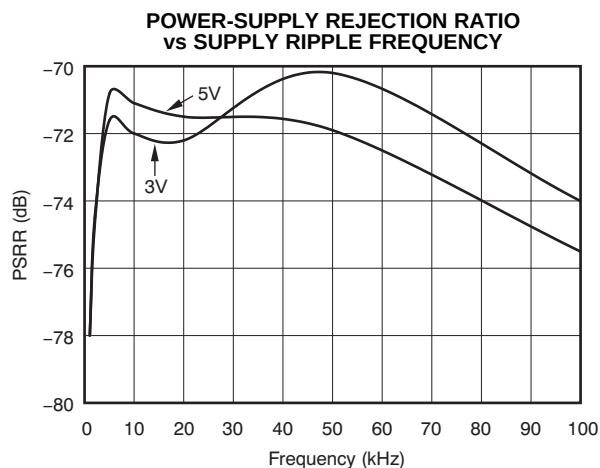


Figure 17.

## TYPICAL CHARACTERISTICS (continued)

At  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ ,  $V_{\text{REF}}[(\text{REF}+) - (\text{REF}-)] = 5\text{V}$  when  $+V_A = +V_{\text{BD}} = 5\text{V}$  or  $V_{\text{REF}}[(\text{REF}+) - (\text{REF}-)] = 2.5\text{V}$  when  $+V_A = +V_{\text{BD}} = 3\text{V}$ ,  $f_{\text{SCLK}} = 42\text{MHz}$ , or  $V_{\text{REF}} = 2.5$  when  $+V_A = +V_{\text{BD}} = 2.7\text{V}$ ,  $f_{\text{SCLK}} = 37.8\text{MHz}$ , and  $f_i = \text{dc}$  for dc curves,  $f_i = 100\text{kHz}$  for ac curves with  $5\text{V}$  supply, and  $f_i = 10\text{kHz}$  for ac curves with  $3\text{V}$  supply, unless otherwise noted.

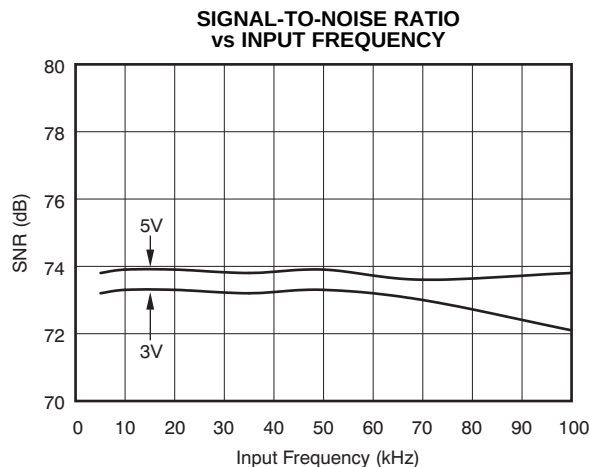


Figure 18.

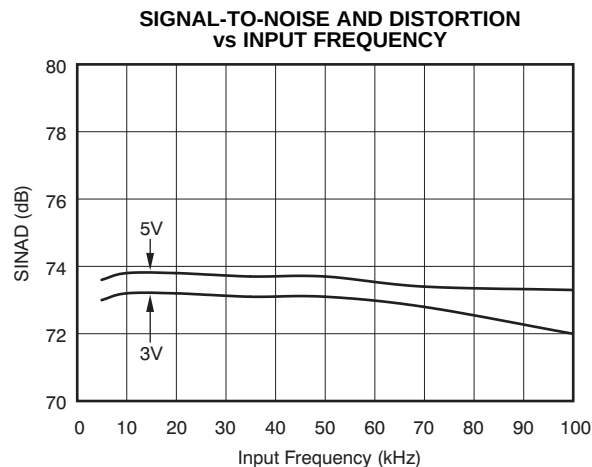


Figure 19.

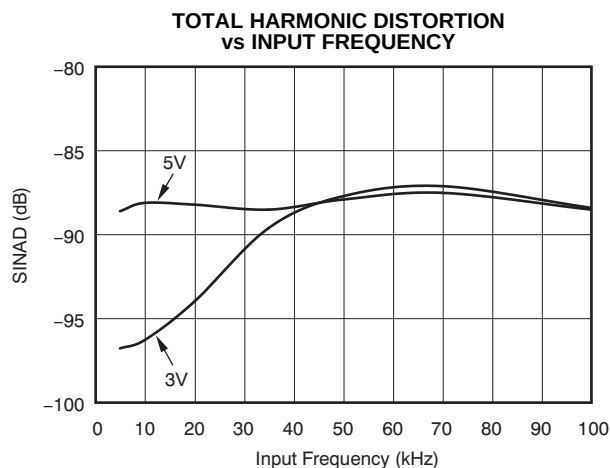


Figure 20.

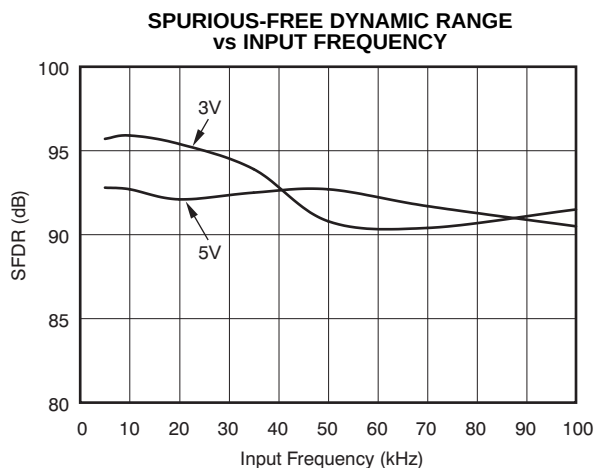


Figure 21.

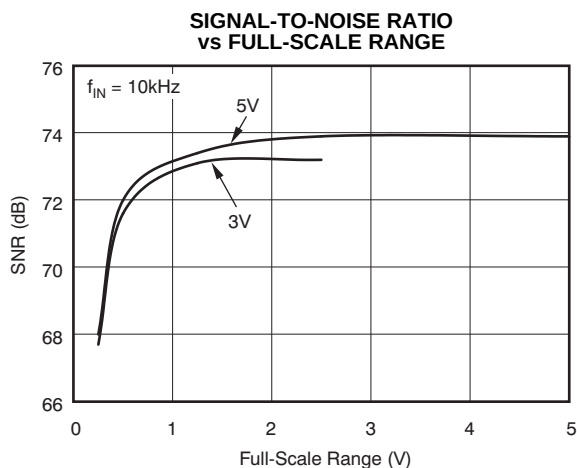


Figure 22.

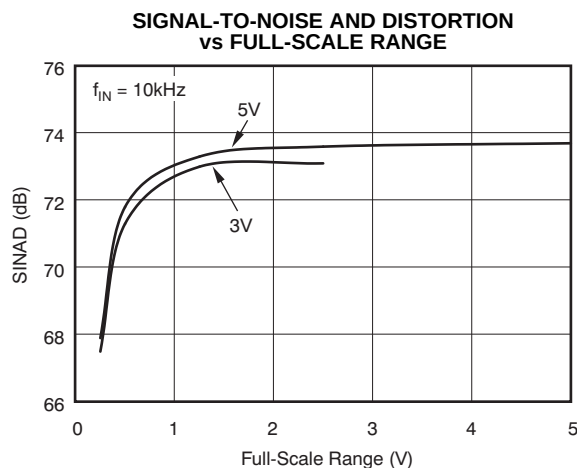


Figure 23.

## TYPICAL CHARACTERISTICS (continued)

At  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ ,  $V_{\text{REF}}[(\text{REF}+) - (\text{REF}-)] = 5\text{V}$  when  $+V_A = +V_{\text{BD}} = 5\text{V}$  or  $V_{\text{REF}}[(\text{REF}+) - (\text{REF}-)] = 2.5\text{V}$  when  $+V_A = +V_{\text{BD}} = 3\text{V}$ ,  $f_{\text{SCLK}} = 42\text{MHz}$ , or  $V_{\text{REF}} = 2.5$  when  $+V_A = +V_{\text{BD}} = 2.7\text{V}$ ,  $f_{\text{SCLK}} = 37.8\text{MHz}$ , and  $f_i = \text{dc}$  for dc curves,  $f_i = 100\text{kHz}$  for ac curves with  $5\text{V}$  supply, and  $f_i = 10\text{kHz}$  for ac curves with  $3\text{V}$  supply, unless otherwise noted.

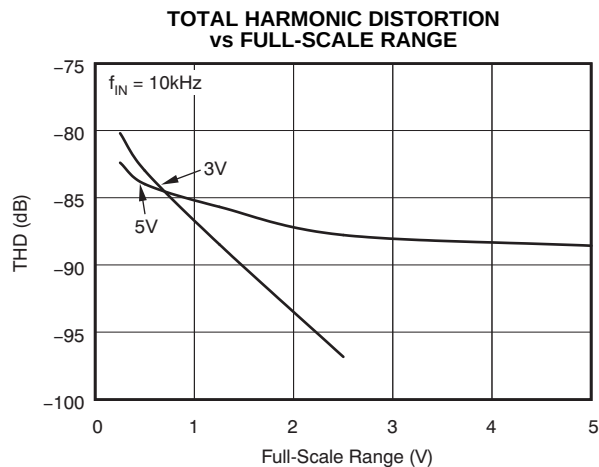


Figure 24.

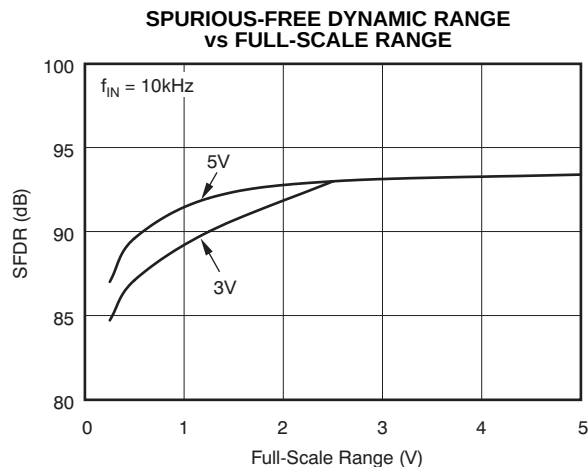


Figure 25.

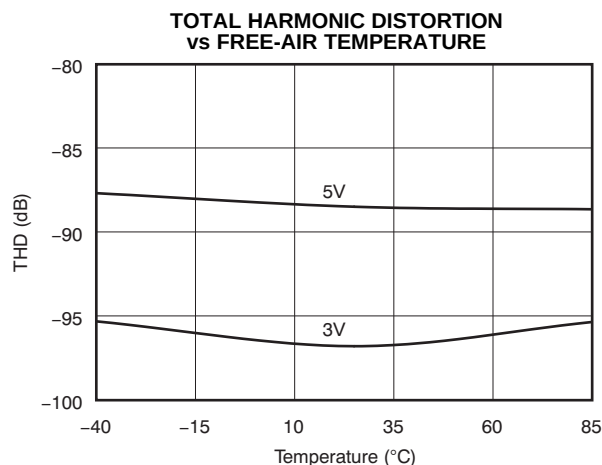


Figure 26.

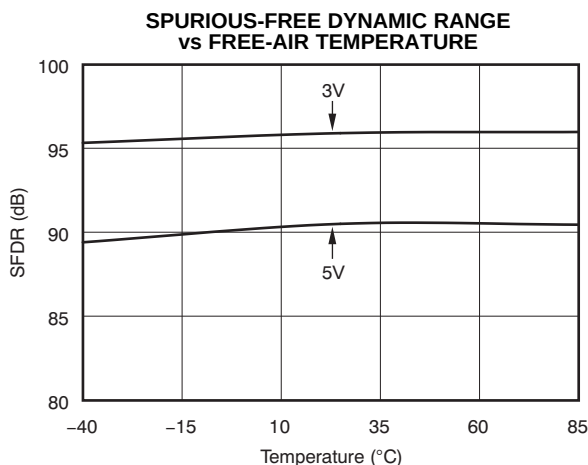


Figure 27.

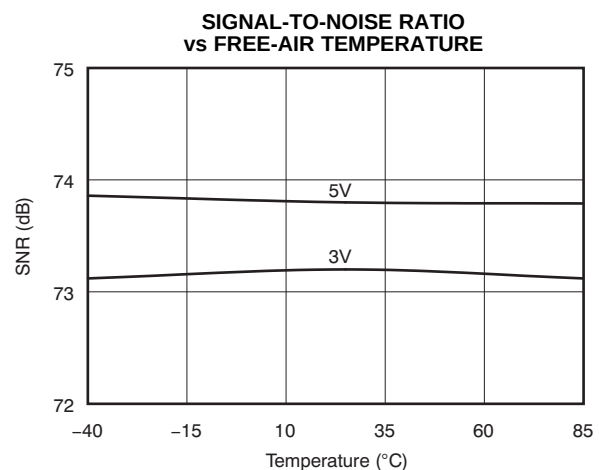


Figure 28.

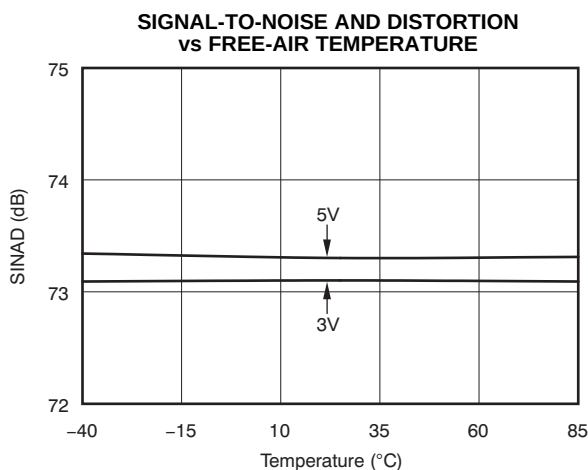


Figure 29.

## TYPICAL CHARACTERISTICS (continued)

At  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ ,  $V_{\text{REF}}[(\text{REF}+) - (\text{REF}-)] = 5\text{V}$  when  $+VA = +VBD = 5\text{V}$  or  $V_{\text{REF}}[(\text{REF}+) - (\text{REF}-)] = 2.5\text{V}$  when  $+VA = +VBD = 3\text{V}$ ,  $f_{\text{SCLK}} = 42\text{MHz}$ , or  $V_{\text{REF}} = 2.5$  when  $+VA = +VBD = 2.7\text{V}$ ,  $f_{\text{SCLK}} = 37.8\text{MHz}$ , and  $f_i = \text{dc}$  for dc curves,  $f_i = 100\text{kHz}$  for ac curves with  $5\text{V}$  supply, and  $f_i = 10\text{kHz}$  for ac curves with  $3\text{V}$  supply, unless otherwise noted.

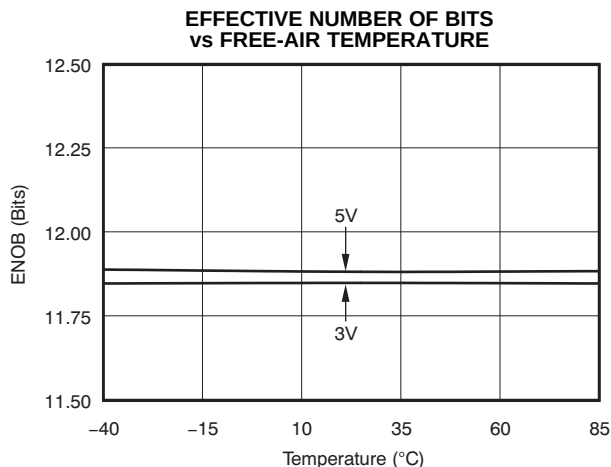


Figure 30.

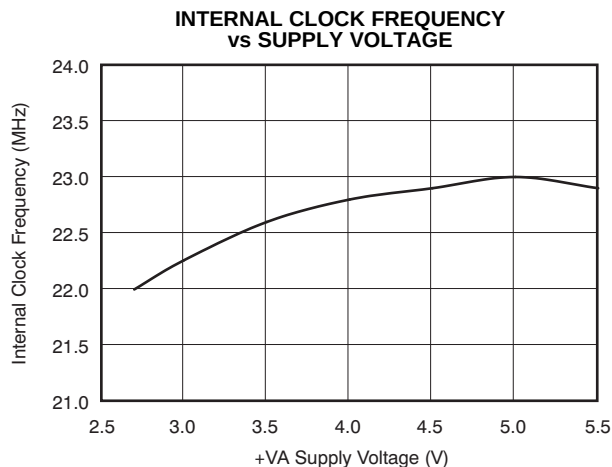


Figure 31.

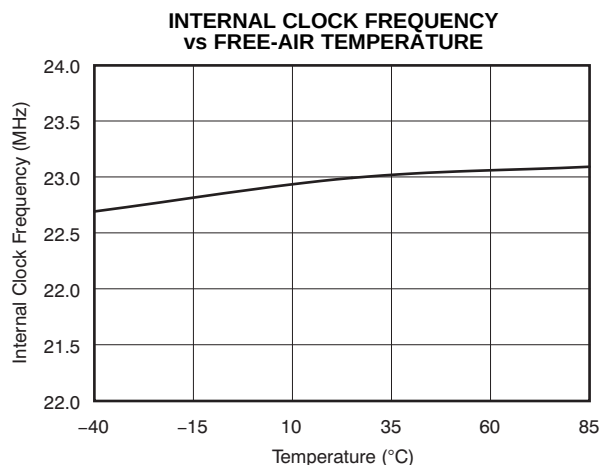


Figure 32.

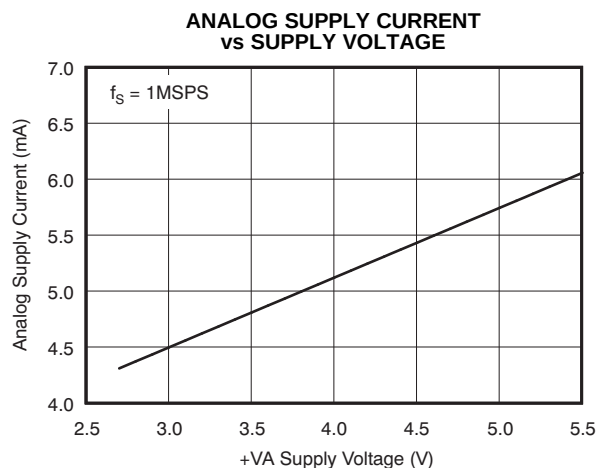


Figure 33.

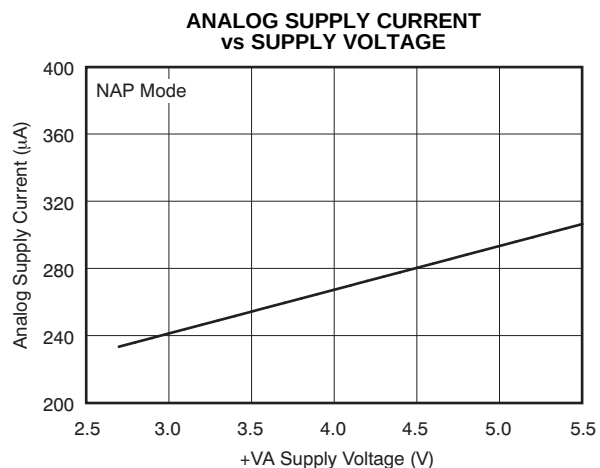


Figure 34.

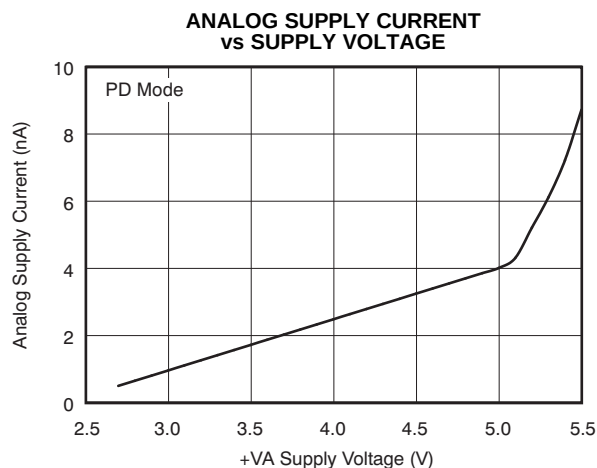


Figure 35.

## TYPICAL CHARACTERISTICS (continued)

At  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ ,  $V_{\text{REF}}[(\text{REF}+) - (\text{REF}-)] = 5\text{V}$  when  $+VA = +VBD = 5\text{V}$  or  $V_{\text{REF}}[(\text{REF}+) - (\text{REF}-)] = 2.5\text{V}$  when  $+VA = +VBD = 3\text{V}$ ,  $f_{\text{SCLK}} = 42\text{MHz}$ , or  $V_{\text{REF}} = 2.5$  when  $+VA = +VBD = 2.7\text{V}$ ,  $f_{\text{SCLK}} = 37.8\text{MHz}$ , and  $f_i = \text{dc}$  for dc curves,  $f_i = 100\text{kHz}$  for ac curves with  $5\text{V}$  supply, and  $f_i = 10\text{kHz}$  for ac curves with  $3\text{V}$  supply, unless otherwise noted.

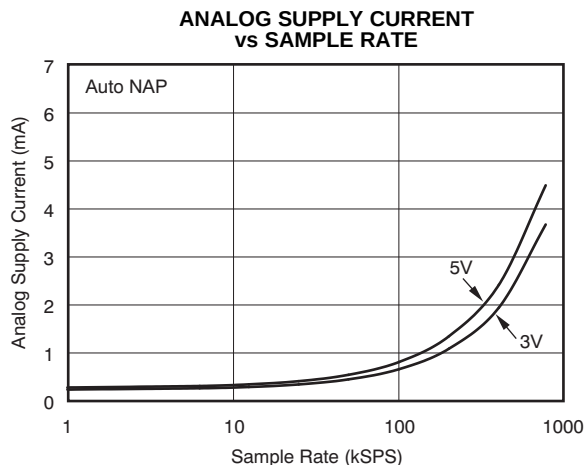


Figure 36.

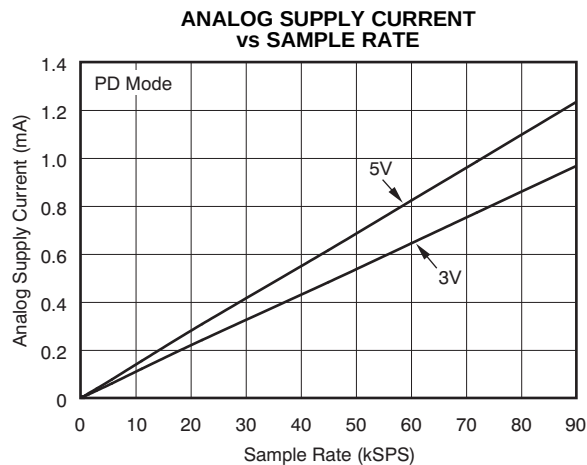


Figure 37.

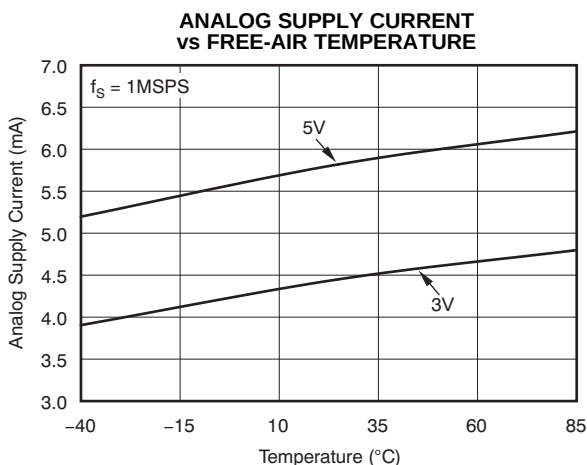


Figure 38.

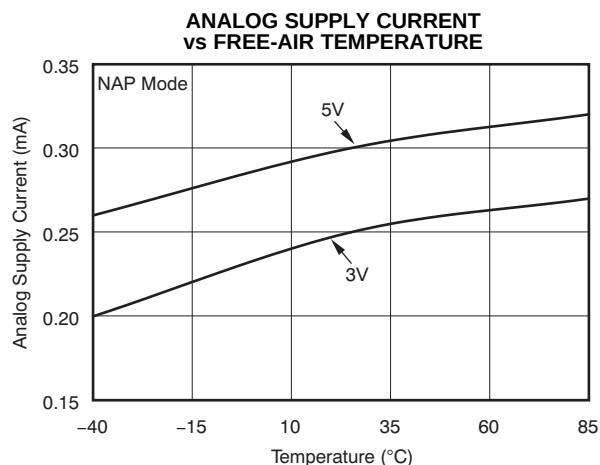


Figure 39.

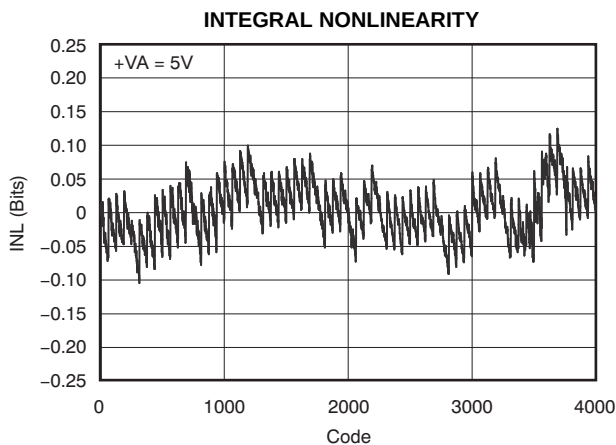


Figure 40.

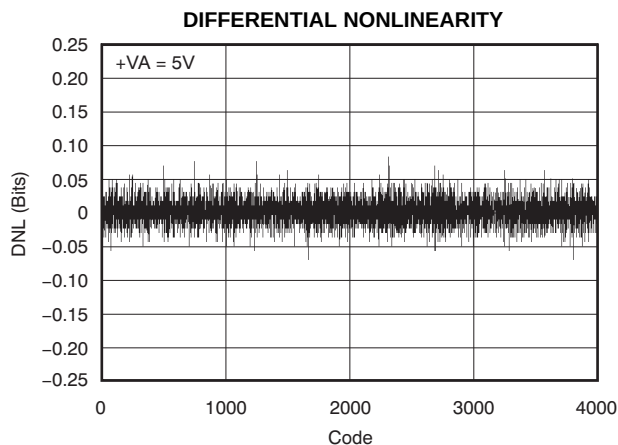


Figure 41.

## TYPICAL CHARACTERISTICS (continued)

At  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ ,  $V_{\text{REF}}[(\text{REF}+) - (\text{REF}-)] = 5\text{V}$  when  $+VA = +VBD = 5\text{V}$  or  $V_{\text{REF}}[(\text{REF}+) - (\text{REF}-)] = 2.5\text{V}$  when  $+VA = +VBD = 3\text{V}$ ,  $f_{\text{SCLK}} = 42\text{MHz}$ , or  $V_{\text{REF}} = 2.5$  when  $+VA = +VBD = 2.7\text{V}$ ,  $f_{\text{SCLK}} = 37.8\text{MHz}$ , and  $f_i = \text{dc}$  for dc curves,  $f_i = 100\text{kHz}$  for ac curves with  $5\text{V}$  supply, and  $f_i = 10\text{kHz}$  for ac curves with  $3\text{V}$  supply, unless otherwise noted.

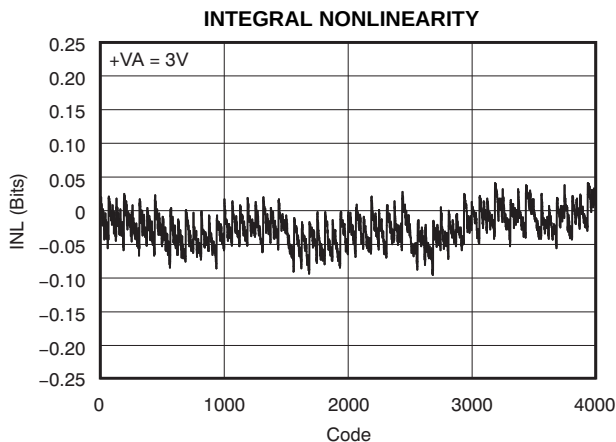


Figure 42.

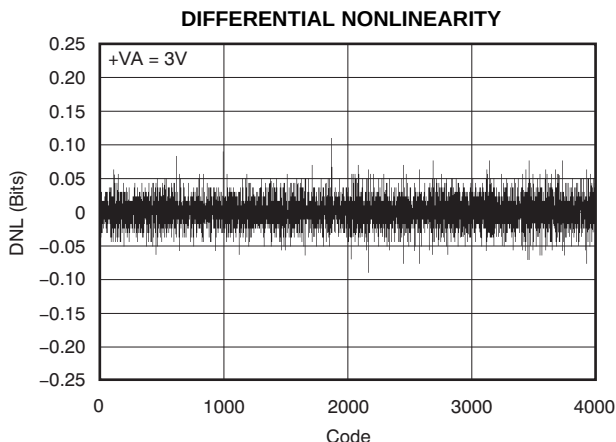


Figure 43.

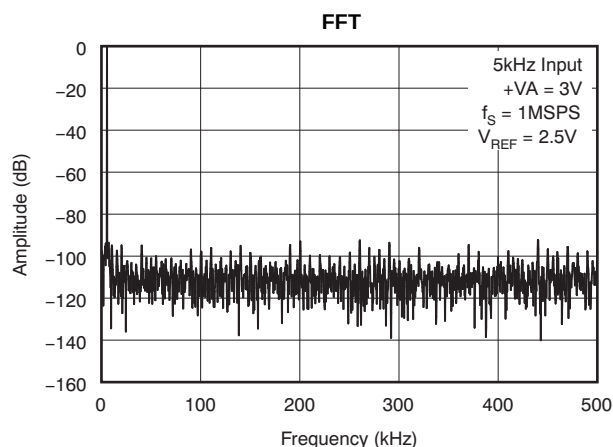


Figure 44.

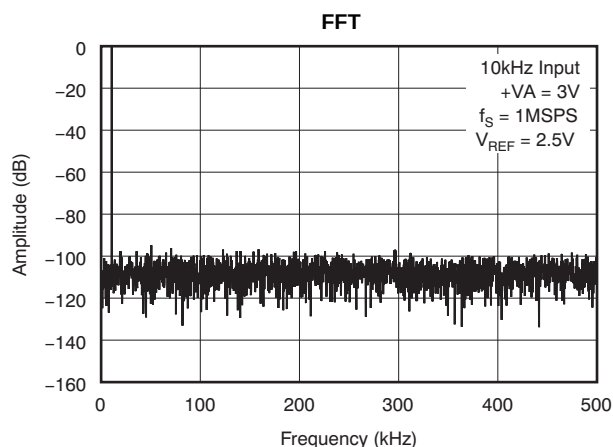


Figure 45.

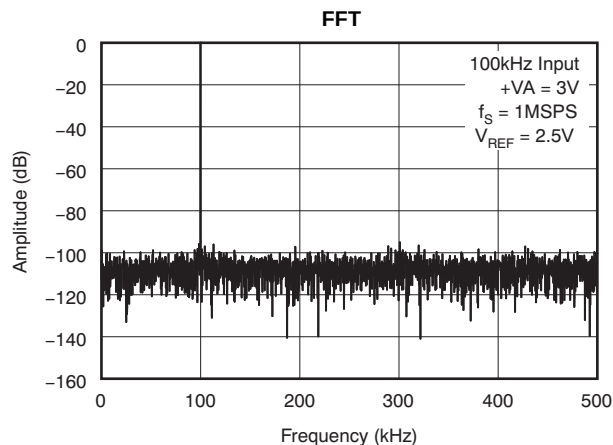


Figure 46.

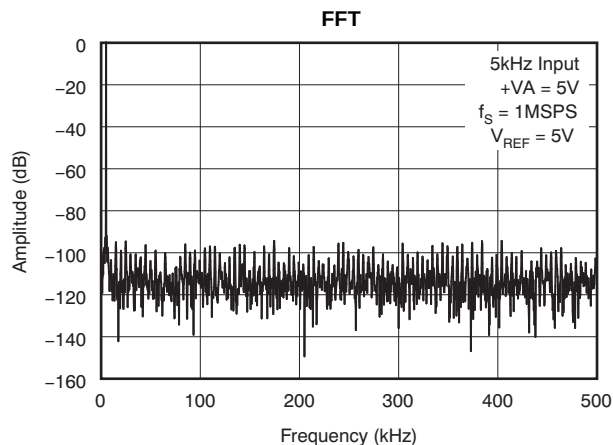


Figure 47.

## TYPICAL CHARACTERISTICS (continued)

At  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ ,  $V_{\text{REF}}[(\text{REF}+) - (\text{REF}-)] = 5\text{V}$  when  $+V_A = +V_{\text{BD}} = 5\text{V}$  or  $V_{\text{REF}}[(\text{REF}+) - (\text{REF}-)] = 2.5\text{V}$  when  $+V_A = +V_{\text{BD}} = 3\text{V}$ ,  $f_{\text{SCLK}} = 42\text{MHz}$ , or  $V_{\text{REF}} = 2.5$  when  $+V_A = +V_{\text{BD}} = 2.7\text{V}$ ,  $f_{\text{SCLK}} = 37.8\text{MHz}$ , and  $f_i = \text{dc}$  for dc curves,  $f_i = 100\text{kHz}$  for ac curves with  $5\text{V}$  supply, and  $f_i = 10\text{kHz}$  for ac curves with  $3\text{V}$  supply, unless otherwise noted.

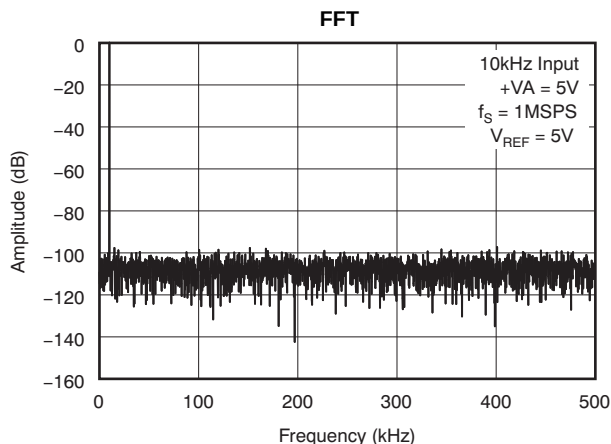


Figure 48.

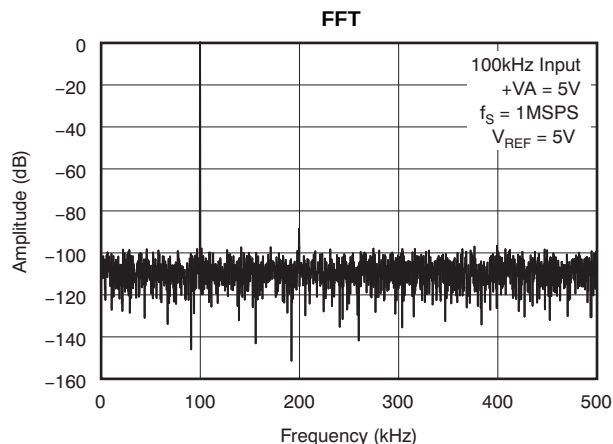


Figure 49.

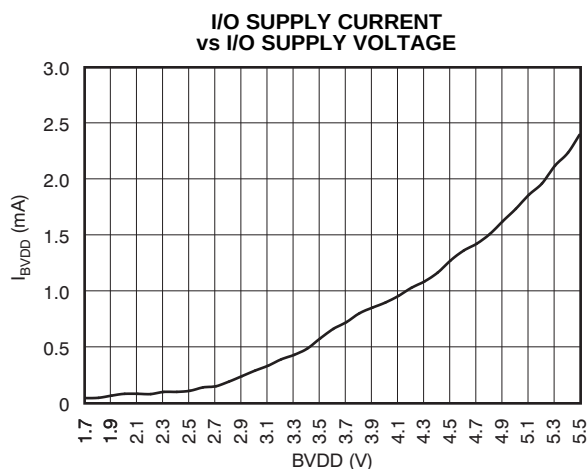


Figure 50.

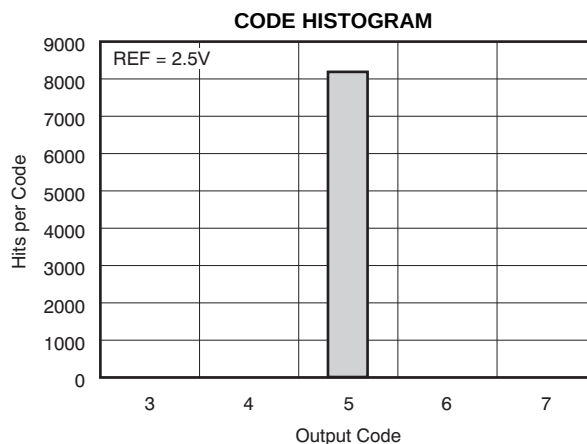


Figure 51.

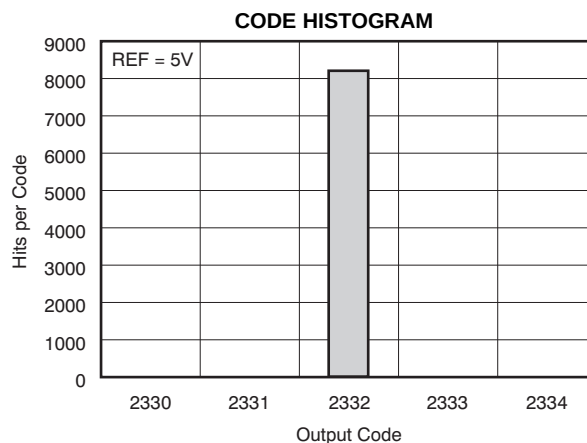


Figure 52.

## THEORY OF OPERATION

The ADS7229 and ADS7230 are two high-speed, low power, successive approximation register (SAR) analog-to-digital converters (ADCs) that use an external reference. The architecture is based on charge redistribution, which inherently includes a sample-and-hold function.

These devices have an internal clock that is used to run the conversion; these devices can also be programmed to run the conversion based on the external serial clock, SCLK.

The ADS7229 has one analog input. The analog input is provided to two input pins: +IN and –IN. When a conversion is initiated, the differential input on these pins is sampled on the internal capacitor array. While a conversion is in progress, both +IN and –IN inputs are disconnected from any internal function.

The ADS7230 has two inputs. Both inputs share the same common pin, COM. The negative input is the same as the –IN pin for the ADS7229. The ADS7230 can be programmed to select a channel manually or can be programmed into the auto channel select mode to sweep between channel 0 and channel 1 automatically.

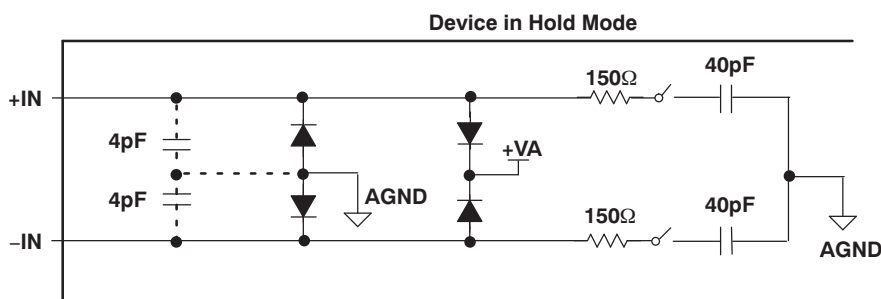
Throughout this document, the term *ADS7229/30* refers to both devices, unless specifically noted otherwise.

## ANALOG INPUT

When the converter enters before hold mode, the voltage difference between the +IN and –IN inputs is captured on the internal capacitor array. The voltage on the –IN input is limited between AGND – 0.2V and AGND + 0.2V, allowing the input to reject small signals that are common to both the +IN and –IN inputs. The +IN input has a range of –0.2V to ( $V_{REF} + 0.2V$ ). The input span [(+IN) – (–IN)] is limited to 0V to  $V_{REF}$ .

The (peak) input current through the analog inputs depends upon a number of factors: sample rate, input voltage, and source impedance. The current into the ADS7229/30 charges the internal capacitor array during the sample period. After this capacitance has been fully charged, there is no further input current. The source of the analog input voltage must be able to charge the input capacitance (45pF) to a 12-bit settling level within the minimum acquisition time (120ns). When the converter goes into hold mode, the input impedance is greater than 1GΩ.

Care must be taken regarding the absolute analog input voltage. To maintain linearity of the converter, the +IN and –IN inputs and the span [(+IN) – (–IN)] should be within the limits specified. Outside of these ranges, converter linearity may not meet specifications. To minimize noise, low bandwidth input signals with low-pass filters should be used. Care should be taken to ensure that the output impedance of the sources driving the +IN and –IN inputs are matched. If this input matching is not observed, the two inputs could have different settling times. This difference may result in an offset error, gain error, and linearity errors that change with temperature and input voltage.



**Figure 53. Input Equivalent Circuit**

## Driver Amplifier Choice

The analog input to the converter must be driven with a low-noise operational amplifier such as the [THS4031](#) or [OPA365](#). An RC filter is recommended at the input pins to low-pass filter the noise from the source. Two 20Ω resistors and a 470pF capacitor are recommended. The input to the converter is a unipolar input voltage in the range of 0V to  $V_{REF}$ . The minimum -3dB bandwidth of the driving operational amplifier can be calculated as:

$$f_{3db} = (\ln(2) \times (n + 1)) / (2\pi \times t_{ACQ})$$

where  $n$  is equal to 12, the resolution of the ADC (in the case of the ADS7229/30). When  $t_{ACQ} = 120\text{ns}$  (minimum acquisition time), the minimum bandwidth of the driving amplifier is 12MHz. The bandwidth can be relaxed if the acquisition time is increased by the application. The OPA365 or THS4031 from Texas Instruments are recommended. The THS4031 used in the source follower configuration to drive the converter is shown in a typical input drive configuration, [Figure 54](#). For the ADS7230, a series resistor of 0Ω should be used on the COM input (or no resistor at all).

## Bipolar to Unipolar Driver

In systems where the input is bipolar, the THS4031 can be used in the inverting configuration with an additional dc bias applied to its positive input to keep the input to the ADS7229/30 within the rated operating voltage range. This configuration is also recommended when the ADS7229/30 is used in signal processing applications where good SNR and THD performance are required. The dc bias can be derived from the [REF5025](#) or the [REF5040](#) reference voltage ICs. The input configuration shown in [Figure 55](#) is capable of delivering better than 72dB SNR and -88.5dB THD at an input frequency of 10kHz. If bandpass filters are used to filter the input, care should be taken to ensure that the signal swing at the input of the bandpass filter is small in order to keep the distortion introduced by the filter minimal. In such cases, the gain of the circuit shown in [Figure 55](#) can be increased to keep the input to the ADS7229/30 large in order to maintain a high SNR of the system. Note that the gain of the system from the positive input to the output of the THS4031 in such a configuration is a function of the ac signal gain. A resistor divider can be used to scale the output of the [REF5025](#) or [REF5040](#) to reduce the voltage at the dc input to the THS4031 to maintain the voltage at the converter input within its rated operating range.

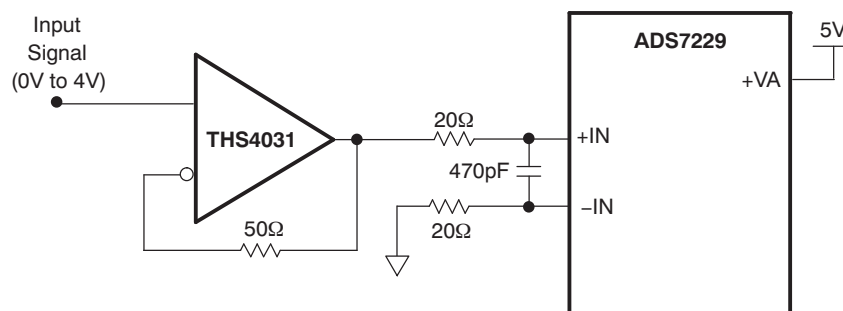


Figure 54. Unipolar Input Drive Configuration

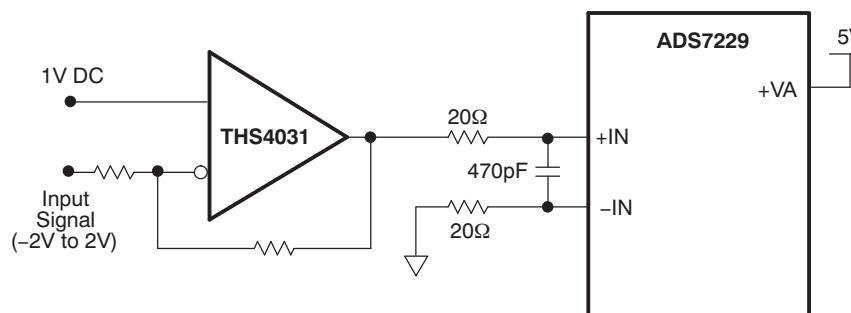


Figure 55. Bipolar Input Drive Configuration

## REFERENCE

The ADS7229/30 must operate with an external reference with a range from 0.3V to 5V. A clean, low-noise, well-decoupled reference voltage on this pin is required to ensure good converter performance. A low-noise bandgap reference such as the REF5040 can be used to drive this pin. A 22µF ceramic decoupling capacitor is required between the REF+ and REF– pins of the converter. These capacitors should be placed as close as possible to the device pins. REF– should be connected to its own via to the analog ground plane with the shortest possible distance. A series resistor between the reference and the REF50xx is neither required (because the REF50xx is capable of driving a 22µF capacitor while maintaining stability) nor recommended (due to additional nonlinearity); see also Figure 68.

## CONVERTER OPERATION

The ADS7229/30 has an oscillator that is used as an internal clock that controls the conversion rate. The frequency of this clock is 21MHz minimum. The oscillator is always on unless the device is in the deep power-down state or the device is programmed for using SCLK as the conversion clock (CCLK). The minimum acquisition (sampling) time takes 3 CCLKs (equivalent to 143ns at 21MHz) and the conversion time takes 18 conversion clocks (CCLK) or approximately 857ns at 21MHz to complete one conversion.

The conversion can also be programmed to run based on the external serial clock, SCLK. This option allows a system designer to achieve system synchronization. The serial clock SCLK, is first reduced to 1/2 of its frequency before it is used as the conversion clock (CCLK). For example, with a 42MHz SCLK, this reduction provides a 21MHz clock for conversions. If it is desired to start a conversion at a specific rising edge of SCLK when the external SCLK is programmed as the source of the conversion clock (and manual conversion start is selected), the setup time between  $\overline{\text{CONVST}}$  and that rising SCLK edge should be observed. This configuration ensures that the conversion is complete in 18 CCLKs (or 36 SCLKs). The minimum setup time is 20ns to ensure synchronization between  $\overline{\text{CONVST}}$  and SCLK. In many cases, the conversion can start one SCLK period (or CCLK) later, which results in a conversion of 19 CCLKs (or 37 SCLKs). The 20ns setup time is not required if the synchronization is not critical in the application.

The duty cycle of SCLK is not critical as long as it meets the minimum high and low time requirements of 8ns. The ADS7229/30 is designed for high-speed applications; therefore, a higher serial clock (SCLK) must be supplied to be able to sustain the high throughput with the serial interface. As a result, the clock period of SCLK must be at most 1µs (when used as the conversion clock, CCLK). The minimum clock frequency is also governed by the parasitic leakage of the capacitive digital-to-analog (CDAC) capacitors internal to the ADS7229/30.

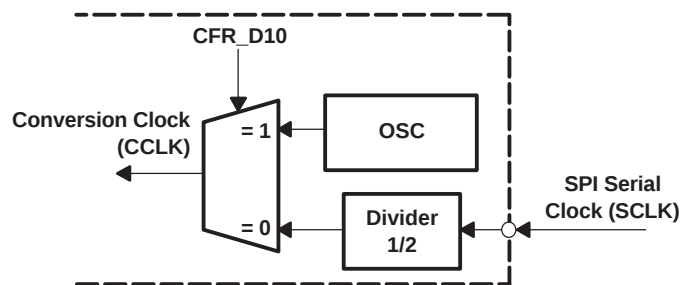


Figure 56. Converter Clock

## Manual Channel Select Mode

The conversion cycle starts with selecting an acquisition channel by writing a channel number to the command register, CMR. The command length can be as short as four SCLKs.

## Auto Channel Select Mode

Channel selection can also be done automatically if auto channel select mode is enabled. This mode is the default channel select mode. The dual channel converter, ADS7230, has an onboard 2-to-1 MUX. If the device is programmed for auto channel select mode, then signals from channel 0 and channel 1 are acquired with a fixed order. Channel 0 is accessed first in the next cycle after the command cycle that configured CFR\_D11 to '1' for auto channel select mode. This automatic access stops the cycle after the command cycle that sets CFR\_D11 to '0'.

## Start of a Conversion

The end of sampling instance (EOS) or acquisition is the same as the start of a conversion. This event is initiated by bringing the CONVST pin low for a minimum of 40ns. After the minimum requirement has been met, the CONVST pin can be brought high. CONVST acts independently of FS/CS so it is possible to use one common CONVST for applications that require a simultaneous sample/hold with multiple converters. The ADS7229/30 switches from sample to hold mode on the falling edge of the CONVST signal. The ADS7229/30 requires 18 conversion clock (CCLK) edges to complete a conversion. The conversion time is equivalent to 857ns with a 21MHz internal clock. The minimum time between two consecutive CONVST signals is 21 CCLKs.

A conversion can also be initiated without using CONVST if it is so programmed (CFR\_D9 = 0). When the converter is configured as an auto trigger, the next conversion automatically starts three conversion clocks (CCLK) after the end of a conversion. These three conversion clocks are used as the acquisition time. In this case, the time to complete one acquisition and conversion cycle is 21 CCLKs. Table 1 summarizes the different conversion modes.

**Table 1. Different Types of Conversion**

| MODE      | SELECT CHANNEL                                                                      | START CONVERSION                                       |
|-----------|-------------------------------------------------------------------------------------|--------------------------------------------------------|
| Automatic | Auto Channel Select <sup>(1)</sup>                                                  | Auto Trigger                                           |
|           | No need to write channel number to the CMR. Use internal sequencer for the ADS7230. | Start a conversion based on the conversion clock CCLK. |
| Manual    | Manual Channel Select                                                               | Manual Trigger                                         |
|           | Write the channel number to the CMR.                                                | Start a conversion with CONVST.                        |

(1) Auto channel select should be used with the TAG bit enabled.

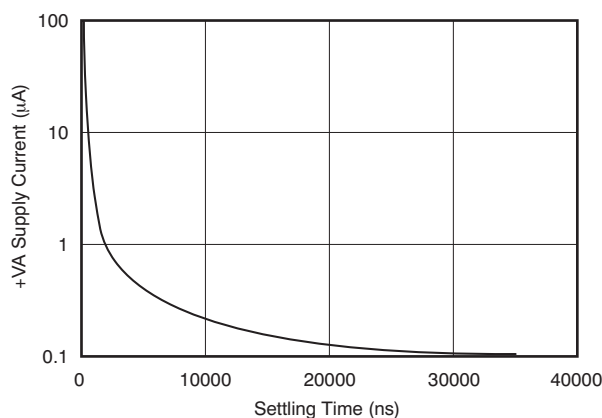
## Status Output EOC/INT

When the status pin is programmed as EOC and the polarity is set as active low, the pin works in the following manner: The EOC output goes low immediately after CONVST goes low when the manual trigger is programmed. EOC stays low throughout the conversion process and returns high when the conversion ends. The EOC output goes low for three conversion clocks after the previous rising edge of EOC, if auto trigger is programmed.

This status pin is programmable. It can be used as an EOC output (CFR\_D[7:6] = 1, 1) where the low time is equal to the conversion time. This status pin can also be used as INT (CFR\_D[7:6] = 1, 0), which is set low as the end of a conversion is brought high (cleared) by the next read cycle. The polarity of this pin, used as either function (EOC or INT), is programmable through CFR\_D7.

## Power-Down Modes

The ADS7229/30 has a comprehensive, built-in power-down feature. There are three power-down modes: Deep power-down mode, Nap power-down mode, and Auto nap power-down mode. All three power-down modes are enabled by setting the related CFR bits. The first two power-down modes are activated when enabled. A wakeup command, 1011b, resumes device operation from a power-down mode. Auto nap power-down mode works slightly differently. When the converter is enabled in Auto nap power-down mode, an end of conversion instance (EOC) puts the device into auto nap power-down. The beginning of sampling resumes converter operation. The contents of the configuration register are not affected by any of the power-down modes. Any ongoing conversion when nap or deep power-down is activated is aborted.



**Figure 57. Typical Analog Supply Current Drop versus Time After Power-Down**

### Deep Power-Down Mode

Deep power-down mode can be activated by writing to configuration register bit CFR\_D2. When the device is in Deep power-down mode, all blocks except the interface are in power-down. The external SCLK is blocked to the analog block. The analog blocks no longer have bias currents and the internal oscillator is turned off. In this mode, supply current falls from 5.7mA to 4nA in 100ns. The wake-up time after a deep power-down is 1µs. When bit D2 in the configuration register is set to '0', the device is in Deep power-down. Setting this bit to '1' or sending a wake-up command resumes the converter operation from the Deep power-down state.

### Nap Mode

In Nap mode, the ADS7229/30 turns off biasing of the comparator and the mid-voltage buffer. In this mode, supply current falls from 5.7mA in normal mode to about 0.3mA in 200ns after the configuration cycle. The wake-up (resume) time from Nap power-down mode is 3 CCLKs (143ns with a 21MHz conversion clock). As soon as the CFR\_D3 bit in the control register is set to '0', the device goes into Nap power-down mode, regardless of the conversion state. Setting this bit to '1' or sending a wake-up command resumes converter operation from the Nap power-down state.

## Auto Nap Mode

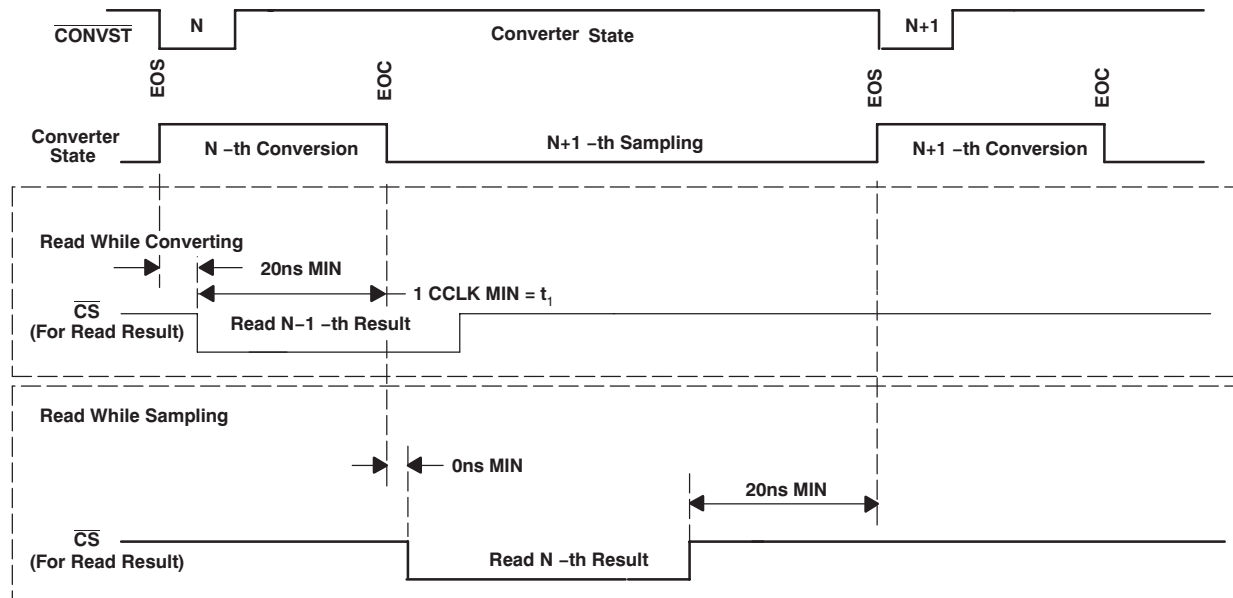
Auto nap mode is almost identical to nap mode. The only difference is the time when the device is actually powered down and the method used to wake up the device. Configuration register bit D4 is only used to enable/disable Auto nap mode. If Auto nap mode is enabled, the device turns off the biasing after the conversion has finished; that is, the end of conversion activates Auto nap power-down mode. Supply current falls from 5.7mA in normal mode to about 0.3mA in 200ns. A  $\overline{\text{CONVST}}$  command resumes the device and turns on the biasing on again in 3 CCLKs (143ns with a 21MHz conversion clock). The device can also be woken up by disabling auto nap mode when bit D4 of the configuration register is set to '1'. Any channel select command 0XXXb, a wake-up command, or the set default mode command 1111b can also wake up the device from Auto nap power-down. Table 2 compares the various power-down modes.

### NOTE:

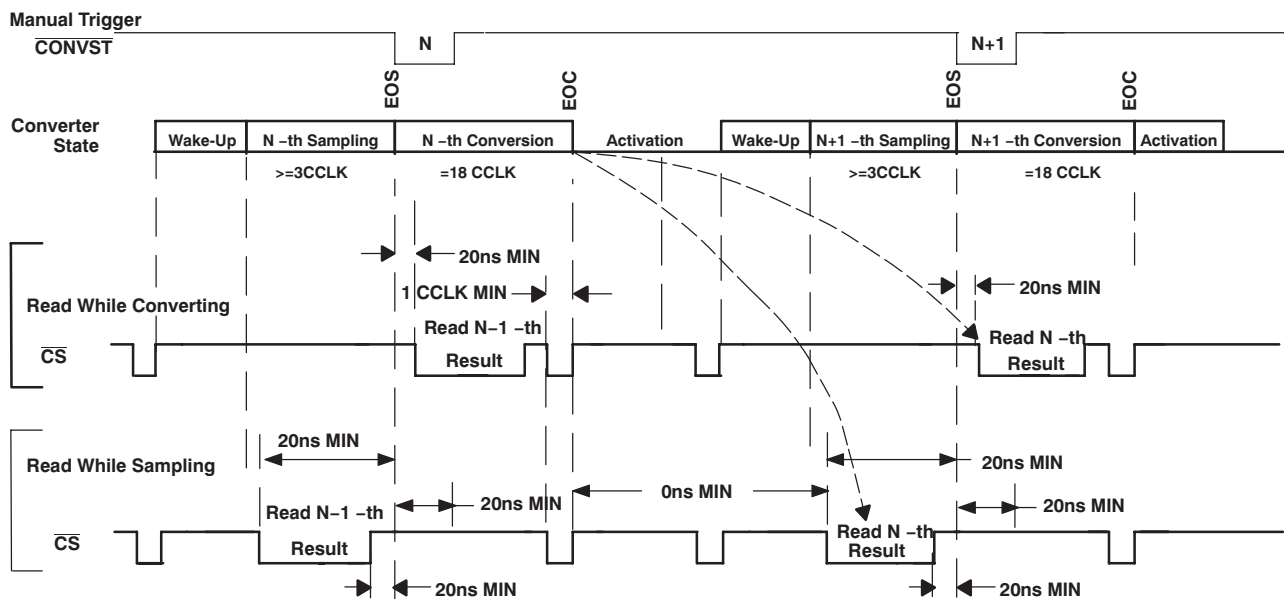
1. This wake-up command is the word 1011b in the command word. This command sets bits D2 and D3 to '1' in the configuration register, but not D4. A wake-up command removes the device from any of these power-down states, Deep/Nap/Auto nap power-down.
2. Wake-up time is defined as the time between when the host processor tries to wake up the converter and when a conversion start can occur.

**Table 2. Power-Down Mode Comparisons**

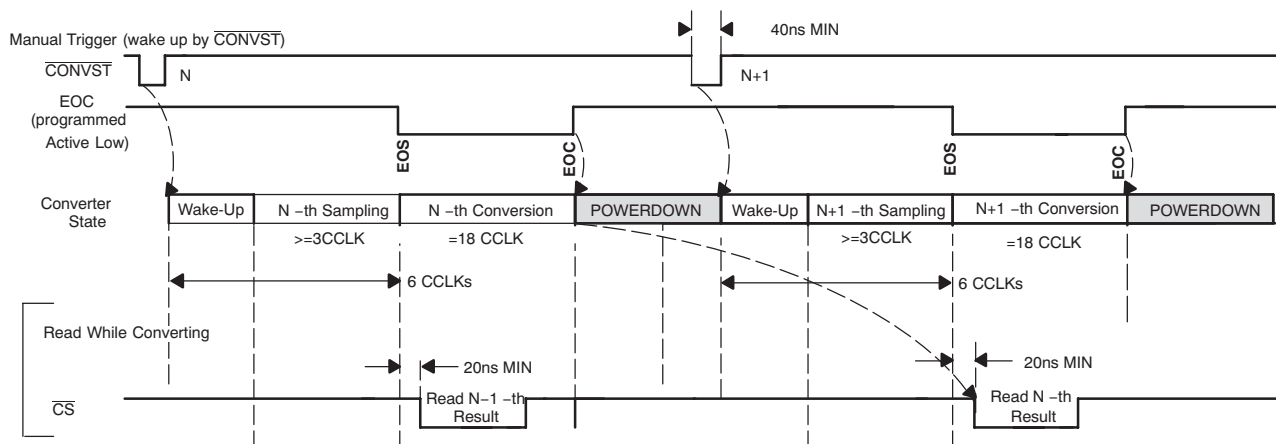
| TYPE OF POWER-DOWN  | SUPPLY CURRENT AT 5V/3V | ACTIVATED BY            | TIME TO POWER-DOWN (ns) | WAKE-UP BY                                                                                                            | WAKE-UP TIME | ENABLE  |
|---------------------|-------------------------|-------------------------|-------------------------|-----------------------------------------------------------------------------------------------------------------------|--------------|---------|
| Normal operation    | 5.7mA/4.5mA             |                         |                         |                                                                                                                       |              |         |
| Deep power-down     | 4nA/1nA                 | Setting CFR             | 100                     | Woken up by command 1011b                                                                                             | 1 $\mu$ s    | Set CFR |
| Nap power-down      | 0.3mA/0.25mA            | Setting CFR             | 200                     | Woken up by command 1011b                                                                                             | 3 CCLKs      | Set CFR |
| Auto nap power-down | 0.3mA/0.25mA            | EOC (end of conversion) | 200                     | Woken up by $\overline{\text{CONVST}}$ , any channel select command, default command 1111b, or wake up command 1011b. | 3 CCLKs      | Set CFR |



**Figure 58. Read While Converting versus Read While Sampling (Manual Trigger)**



**Figure 59. Read While Converting versus Read While Sampling with Deep or Nap Power-Down**



**Figure 60. Read While Converting with Auto Nap Power-Down**

Total Acquisition + Conversion Cycle Time:

Auto trigger: = 21 CCLKs

Manual: ≥ 21 CCLKs

Manual + deep power-down: ≥ 4 SCLK + 100μs + 3 CCLK + 18 CCLK +16 SCLK + 1μs

Manual + nap power-down: ≥ 4 SCLK + 3 CCLK + 3 CCLK + 18 CCLK +16 SCLK

Manual + auto nap power-down: ≥ 1 CCLK + 3 CCLK + 3 CCLK + 18 CCLK +16 SCLK (use  $\overline{\text{CONVST}}$  to resume)

Manual + auto nap power-down: ≥ 4 SCLK + 3 CCLK + 3 CCLK + 18 CCLK +16 SCLK (use wake up to resume)

## DIGITAL INTERFACE

The serial clock is designed to accommodate the latest high-speed processors with an SCLK frequency up to 50MHz. Each cycle starts with the falling edge of  $\overline{FS}/\overline{CS}$ . The internal data register content that is made available to the output register at the EOC (presented on the SDO output pin at the falling edge of  $\overline{FS}/\overline{CS}$ ) is the MSB. Output data are valid at the falling edge of SCLK with a  $t_{d(SCLKF-SDOVALID)}$  delay so that the host processor can read it at the falling edge. Serial data input is also read at the falling edge of SCLK.

The complete serial I/O cycle starts with the first falling edge of SCLK after the falling edge of  $\overline{FS}/\overline{CS}$  and ends 16 falling edges of SCLK later (see NOTE). The serial interface is very flexible. It works with CPOL = 0, CPHA = 1 or CPOL = 1, CPHA = 0. This flexibility means the falling edge of  $\overline{FS}/\overline{CS}$  may fall while SCLK is high. The same relaxation applies to the rising edge of  $\overline{FS}/\overline{CS}$  where SCLK may be high or low as long as the last SCLK falling edge occurs before the rising edge of  $\overline{FS}/\overline{CS}$ .

### NOTE:

There are cases where a cycle is 4 SCLKs or up to 24 SCLKs depending on the read mode combination. See [Table 3](#) and [Table 6](#) for details.

### Internal Register

The internal register consists of two parts, 4 bits for the command register (CMR) and 12 bits for configuration data register (CFR).

**Table 3. Command Set Defined by Command Register (CMR)<sup>(1)</sup>**

| D[15:12] | HEX | COMMAND                                      | D[11:0]    | WAKE-UP FROM<br>AUTO NAP | MINIMUM SCLKs<br>REQUIRED | R/W |
|----------|-----|----------------------------------------------|------------|--------------------------|---------------------------|-----|
| 0000b    | 0h  | Select analog input channel 0 <sup>(2)</sup> | Don't care | Y                        | 4                         | W   |
| 0001b    | 1h  | Select analog input channel 1 <sup>(2)</sup> | Don't care | Y                        | 4                         | W   |
| 0010b    | 2h  | Don't care                                   | Don't care | –                        | –                         | –   |
| 0011b    | 3h  | Don't care                                   | Don't care | –                        | –                         | –   |
| 0100b    | 4h  | Don't care                                   | Don't care | –                        | –                         | –   |
| 0101b    | 5h  | Don't care                                   | Don't care | –                        | –                         | –   |
| 0110b    | 6h  | Don't care                                   | Don't care | –                        | –                         | –   |
| 0111b    | 7h  | Don't care                                   | Don't care | –                        | –                         | –   |
| 1000b    | 8h  | Reserved for factory test, don't use         | Reserved   | –                        | –                         | –   |
| 1001b    | 9h  | Reserved for factory test, don't use         | Reserved   | –                        | –                         | –   |
| 1010b    | Ah  | Reserved for factory test, don't use         | Reserved   | –                        | –                         | –   |
| 1011b    | Bh  | Wake up                                      | Don't care | Y                        | 4                         | W   |
| 1100b    | Ch  | Read CFR                                     | Don't care | –                        | 16                        | R   |
| 1101b    | Dh  | Read data                                    | Don't care | –                        | 12                        | R   |
| 1110     | Eh  | Write CFR                                    | CFR value  | –                        | 16                        | W   |
| 1111b    | Fh  | Default mode (load CFR with default value)   | Don't care | Y                        | 4                         | W   |

(1) When SDO is not in 3-state mode ( $\overline{FS}/\overline{CS}$  low), the bits from SDO are always part of a conversion result (depending on how many SCLKs are supplied).

(2) These two commands apply to the ADS7230 only.

## WRITING TO THE CONVERTER

There are two different types of writes to the register, a 4-bit write to the CMR and a full 16-bit write to the CMR plus CFR. The command set is listed in [Table 3](#). A simple command requires only 4 SCLKs and the write takes effect at the fourth falling edge of SCLK. A 16-bit write or read takes at least 16 SCLKs (see [Table 6](#) for exceptions that require more than 16 SCLKs).

## Configuring the Converter and Default Mode

The converter can be configured with command 1110b (write to the CFR) or command 1111b (default mode). A write to the CFR requires a 4-bit command followed by 12 bits of data. A 4-bit command takes effect at the fourth falling edge of SCLK. A CFR write takes effect at the 16th falling edge of SCLK.

A default mode command can be achieved by simply tying SDI to +VBD. As soon as the chip is selected, at least four '1's are clocked in by SCLK. The default value of the CFR is loaded into the CFR at the fourth falling edge of SCLK.

CFR default values are all 1s (except for CFR\_D1 on the ADS7229; this bit is ignored by the device and is always read as a '0'). The same default values apply for the CFR after a power-on reset (POR) and software reset.

## READING THE CONFIGURATION REGISTER

The host processor can read back the value programmed in the CFR by issuing command 1100b. The timing is similar to reading a conversion result, except that  $\overline{\text{CONVST}}$  is not used and there is no activity on the EOC/ $\overline{\text{INT}}$  pin. The CFR value read back contains the first four MSBs of conversion data plus valid 12-bit CFR contents. Table 4 shows the Configuration Register Map.

**Table 4. Configuration Register (CFR) Map**

| SDI BIT                               | DEFINITION                                                                                                                       |                                                                                                                                 |
|---------------------------------------|----------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------|
| CFR - D[11 - 0]                       |                                                                                                                                  |                                                                                                                                 |
| D11 default = 1                       | Channel select mode                                                                                                              |                                                                                                                                 |
|                                       | 0: Manual channel select enabled. Use channel select commands to access a different channel.                                     | 1: Auto channel select enabled. All channels are sampled and converted sequentially until the cycle after this bit is set to 0. |
| D10 default = 1                       | Conversion clock (CCLK) source select                                                                                            |                                                                                                                                 |
|                                       | 0: Conversion clock (CCLK) = SCLK/2                                                                                              | 1: Conversion clock (CCLK) = Internal OSC                                                                                       |
| D9 default = 1                        | Trigger (conversion start) select: start conversion at the end of sampling (EOS). If D9 = 0, the D4 setting is ignored.          |                                                                                                                                 |
|                                       | 0: Auto trigger automatically starts (4 internal clocks after EOC inactive)                                                      | 1: Manual trigger manually started by falling edge of $\overline{\text{CONVST}}$                                                |
| D8 default = 1                        | Don't care                                                                                                                       |                                                                                                                                 |
|                                       | Don't care                                                                                                                       |                                                                                                                                 |
| D7 default = 1                        | Pin 10 polarity select when used as an output (EOC/ $\overline{\text{INT}}$ )                                                    |                                                                                                                                 |
|                                       | 0: EOC Active high / $\overline{\text{INT}}$ active high                                                                         | 1: EOC active low / $\overline{\text{INT}}$ active low                                                                          |
| D6 default = 1                        | Pin 10 function select when used as an output (EOC/ $\overline{\text{INT}}$ )                                                    |                                                                                                                                 |
|                                       | 0: Pin used as $\overline{\text{INT}}$                                                                                           | 1: Pin used as EOC                                                                                                              |
| D5 default = 1                        | Pin 10 I/O select for chain mode operation                                                                                       |                                                                                                                                 |
|                                       | 0: Pin 10 is used as CDI input (chain mode enabled)                                                                              | 1: Pin 10 is used as EOC/ $\overline{\text{INT}}$ output                                                                        |
| D4 default = 1                        | Auto nap power-down enable/disable (mid voltage and comparator shut down between cycles). This bit setting is ignored if D9 = 0. |                                                                                                                                 |
|                                       | 0: Auto nap power-down enabled (not activated)                                                                                   | 1: Auto nap power-down disabled                                                                                                 |
| D3 default = 1                        | Nap power-down (mid voltage and comparator shut down between cycles). This bit is set to 1 automatically by wake-up command.     |                                                                                                                                 |
|                                       | 0: Enable/activate device in nap power-down                                                                                      | 1: Remove device from nap power-down (resume)                                                                                   |
| D2 default = 1                        | Deep power-down. This bit is set to 1 automatically by wake-up command.                                                          |                                                                                                                                 |
|                                       | 0: Enable/activate device in deep power-down                                                                                     | 1: Remove device from deep power-down (resume)                                                                                  |
| D1 default = 0: ADS7229<br>1: ADS7230 | TAG bit enable. This bit is ignored by the ADS7229 and is always read 0.                                                         |                                                                                                                                 |
|                                       | 0: TAG bit disabled.                                                                                                             | 1: TAG bit output enabled. TAG bit appears at the 17th SCLK.                                                                    |
| D0 default = 1                        | Reset                                                                                                                            |                                                                                                                                 |
|                                       | 0: System reset                                                                                                                  | 1: Normal operation                                                                                                             |

## READING CONVERSION RESULT

The conversion result is available to the input of the output data register (ODR) at EOC and presented to the output of the output register at the next falling edge of  $\overline{\text{CS}}$  or FS. The host processor can then shift the data out via the SDO pin any time except during the quiet zone. This quiet zone is 20ns before and 20ns after the end of sampling (EOS) period. In the quiet zone the FS/ $\overline{\text{CS}}$  should be high, to avoid performance loss when switching from sampling-mode to hold-mode. End of sampling (EOS) is defined as the falling edge of  $\overline{\text{CONVST}}$  when manual trigger is used or the end of the third conversion clock (CCLK) after EOC if auto trigger is used.

The falling edge of  $\overline{\text{FS}}/\overline{\text{CS}}$  should not be placed at the precise moment of the end of a conversion; otherwise, the data may be corrupt. There must be a minimum of at least one conversion clock (CCLK) delay at the end of a conversion. If  $\overline{\text{FS}}/\overline{\text{CS}}$  is placed before the end of a conversion, the previous conversion result is read. If  $\overline{\text{FS}}/\overline{\text{CS}}$  is placed after the end of a conversion, the current conversion result is read.

The conversion result is 12-bit data in straight binary format as shown in Table 5. Generally, 12 SCLKs are necessary, but there are exceptions where more than 12 SCLKs are required (see Table 6). Data output from the serial output (SDO) is left-adjusted, MSB first. The 12-bit conversion result is followed by '0000', the TAG bit (if enabled), and additional zeros. SDO remains low until  $\overline{\text{FS}}/\overline{\text{CS}}$  is brought high again.

**Table 5. Ideal Input Voltages and Output Codes**

| DESCRIPTION                 | ANALOG VALUE                     | DIGITAL OUTPUT<br>STRAIGHT BINARY |          |
|-----------------------------|----------------------------------|-----------------------------------|----------|
|                             |                                  | BINARY CODE                       | HEX CODE |
| Full-scale range            | $V_{\text{REF}}$                 |                                   |          |
| Least significant bit (LSB) | $V_{\text{REF}}/4096$            |                                   |          |
| Full-scale                  | $+V_{\text{REF}} - 1\text{LSB}$  | 1111 1111 1111                    | FFF      |
| Midscale                    | $V_{\text{REF}}/2$               | 1000 0000 0000                    | 800      |
| Midscale – 1LSB             | $V_{\text{REF}}/2 - 1\text{LSB}$ | 0111 1111 1111                    | 7FF      |
| Zero                        | 0V                               | 0000 0000 0000                    | 000      |

SDO is active when  $\overline{\text{FS}}/\overline{\text{CS}}$  is low. The rising edge of  $\overline{\text{FS}}/\overline{\text{CS}}$  3-states the SDO output.

**NOTE:**

Whenever SDO is not in 3-state mode (that is, when  $\overline{\text{FS}}/\overline{\text{CS}}$  is low), a portion of the conversion result is output at the SDO pin. The number of bits depends on how many SCLKs are supplied. For example, a manual select channel command cycle requires 4 SCLKs; therefore, 4MSBs of the conversion result are output at SDO. The exception is that SDO outputs all 1s during the cycle immediately after any reset (POR or software reset).

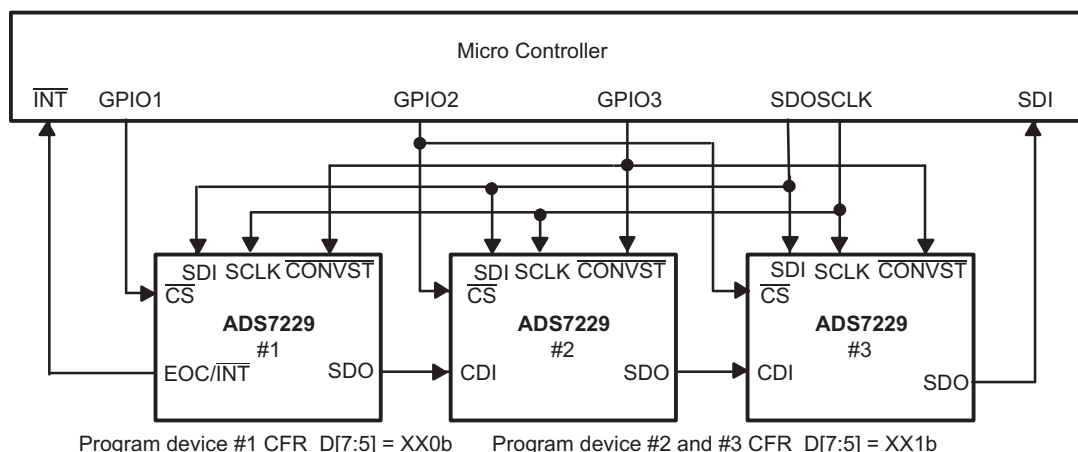
If SCLK is used as the conversion clock (CCLK) and a continuous SCLK is used, it is not possible to clock out all 12 SDO bits during the sampling time (6 SCLKs) because of the quiet zone requirement. In this case, it is better to read the conversion result during the conversion time (36 SCLKs or 48 SCLKs in Auto nap mode).

### TAG Mode

The ADS7230 includes a feature, TAG, that can be used as a tag to indicate which channel sourced the converted result. An address bit is added after the LSB read out from SDO that indicates which channel the result came from if TAG mode is enabled. This address bit is '0' for channel 0 and '1' for channel 1. The converter requires more than the 16 SCLKs that are required for a 4-bit command plus 12-bit CFR or 12 data bits followed by '0000' because of the additional TAG bit.

### Chain Mode

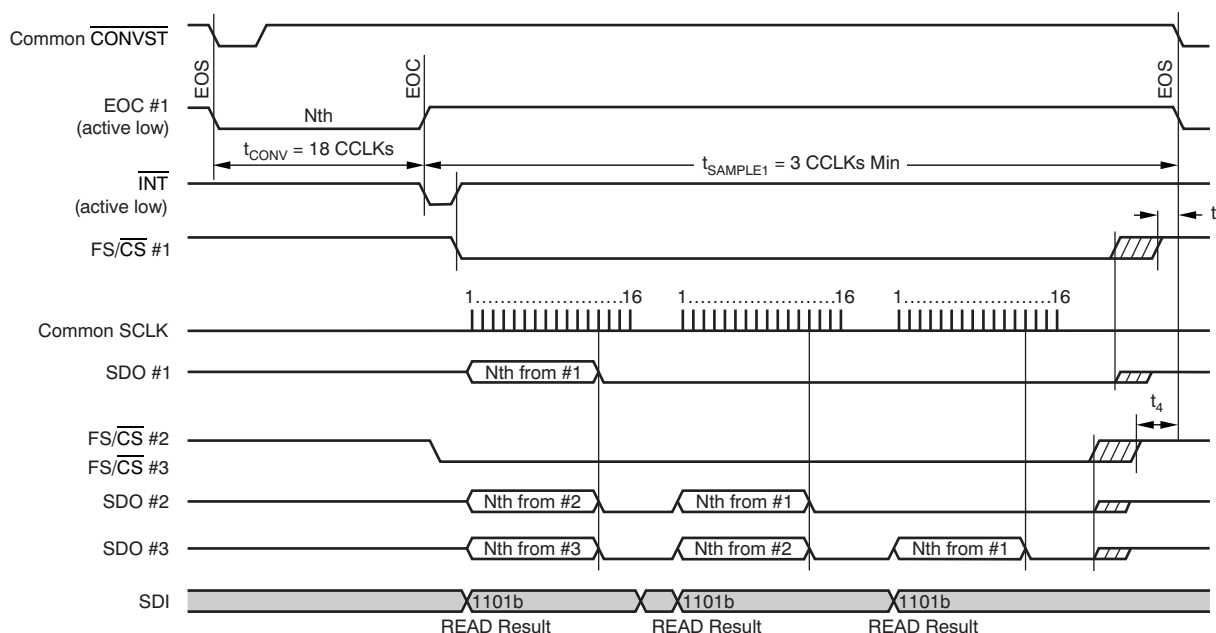
The ADS7229/30 can operate as a single converter or in a system with multiple converters. System designers can take advantage of the simple, high-speed, SPI-compatible serial interface by cascading the devices in a daisy-chain when multiple converters are used. A bit in the CFR is used to reconfigure the EOC/ $\overline{\text{INT}}$  status pin as a secondary serial data input, chain data input (CDI), for the conversion result from an upstream converter. This configuration is chain mode operation. A typical connection of three converters is shown in Figure 61.



**Figure 61. Multiple Converters Connected Using Chain Mode**

When multiple converters are used in daisy-chain mode, the first converter is configured in regular mode while the other converters are configured in chain mode. When a converter is configured in chain mode, the CDI input data go straight to the output register; therefore, the serial input data passes through the converter with a 16 SCLK delay (if the TAG feature is disabled) or a 24 SCLK delay, as long as  $\overline{CS}$  is active. Figure 62 shows a detailed timing diagram. In this timing, the conversions in each device are performed simultaneously.

Cascaded Manual Trigger/Read While Sampling  
(Use internal CCLK, EOC, and INT programmed as active low)  
 $\overline{CS}$  held low during the N times 16 bits transfer cycle



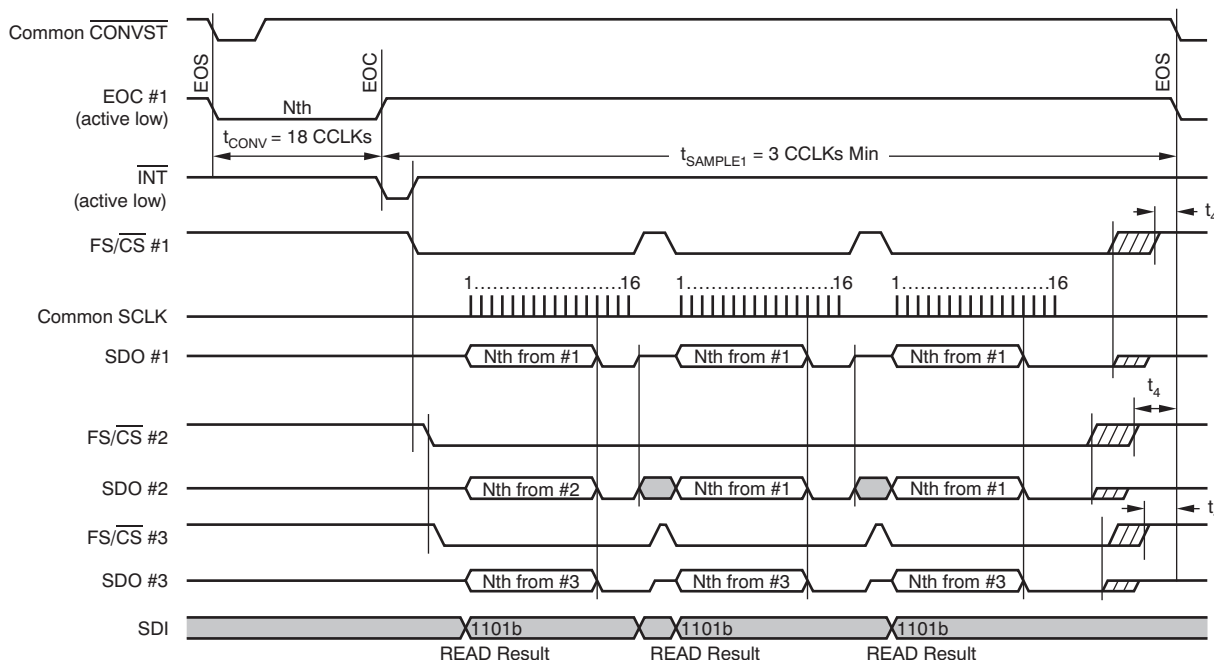
**Figure 62. Simplified Cascade Mode Timing with Shared  $\overline{CONVST}$  and Continuous  $\overline{CS}$**

Care must be given to handle the multiple  $\overline{CS}$  signals when the converters operate in daisy-chain mode. The different chip select signals must be low for the entire data transfer (in this example, 48 bits for three converters). The first 16-bit word after the falling chip select is always the data from the chip that received the chip select signal.

Case 1: If chip select is not toggled ( $\overline{CS}$  stays low), the next 16 bits are data from the upstream converter, and so on. This configuration is shown in Figure 62. If there is no upstream converter in the chain, as with converter #1 in the example, the same data from the converter are going to be shown repeatedly.

Case 2: If the chip select is toggled during a chain mode data transfer cycle, as illustrated in Figure 63, the same data from the converter are read out again and again in all three discrete 16-bit cycles. This result is not a desired outcome.

Cascaded Manual Trigger/Read While Sampling  
(Use internal CCLK, EOC, and INT programmed as active low)



**Figure 63. Simplified Cascade Mode Timing with Shared  $\overline{CONVST}$  and Discrete  $\overline{CS}$**

Figure 64 shows a slightly different scenario where  $\overline{\text{CONVST}}$  is not shared by the second converter. Converters #1 and #3 have the same  $\overline{\text{CONVST}}$  signal. In this case, converter #2 simply passes the previous conversion data downstream.

Cascaded Manual Trigger/Read While Sampling  
(Use internal CCLK, EOC, and INT programmed as active low)  
CS held low during the N times 16 bits transfer cycle

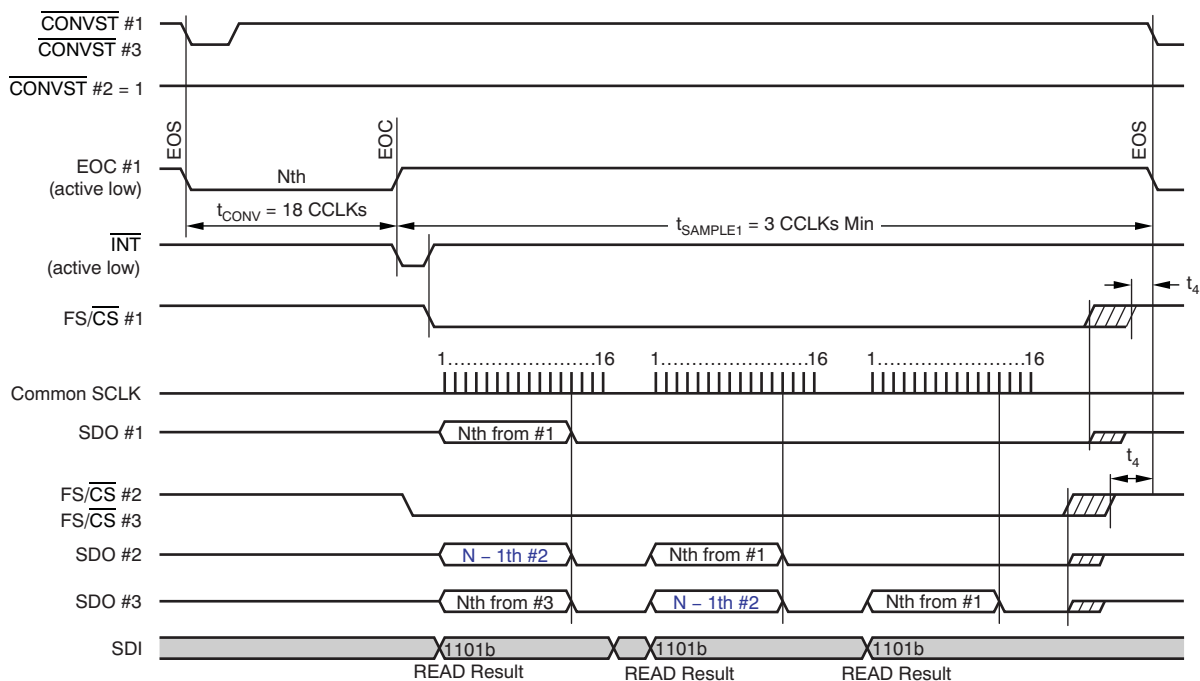


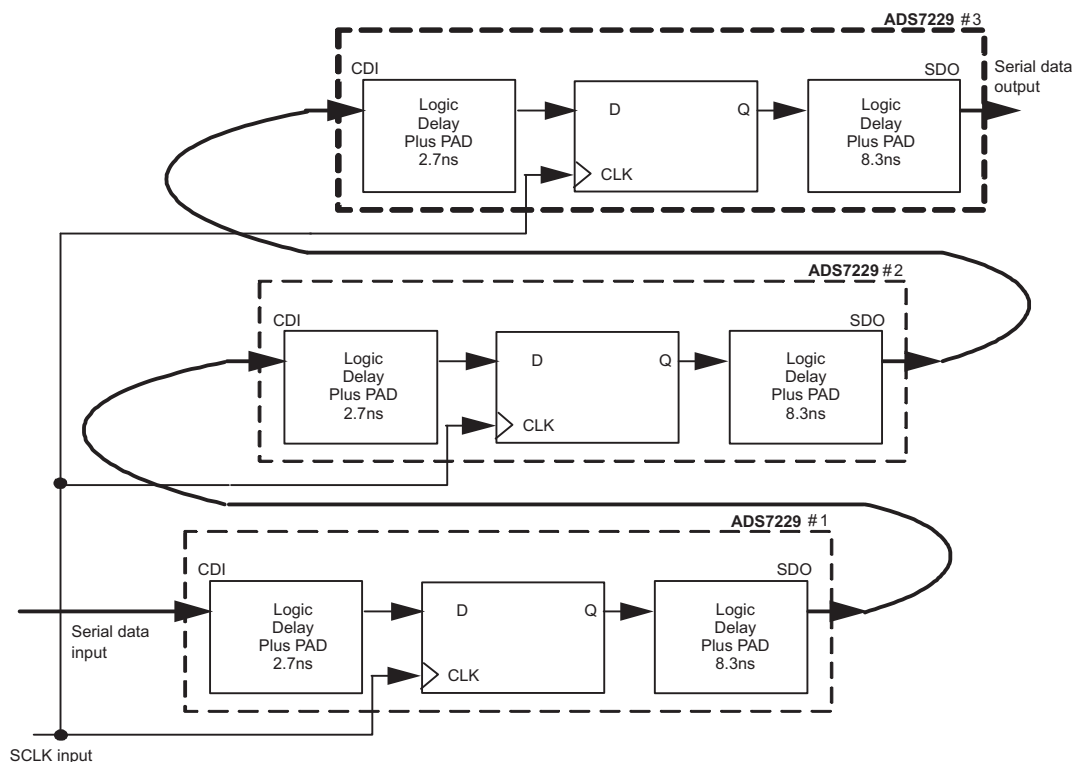
Figure 64. Simplified Cascade Timing (Separate  $\overline{\text{CONVST}}$ )

The number of SCLKs required for a serial read cycle depends on the combination of different read modes, TAG bit, chain mode, and the way a channel is selected (that is, auto channel select). These possible configurations are listed in Table 6.

Table 6. Required SCLKs For Different Read Out Mode Combinations

| CHAIN MODE<br>ENABLED CFR.D5 | AUTO CHANNEL<br>SELECT CFR.D11 | TAG ENABLED CFR.D1 | NUMBER OF SCLK PER SPI<br>READ | TRAILING BITS               |
|------------------------------|--------------------------------|--------------------|--------------------------------|-----------------------------|
| 0                            | 0                              | 0                  | 12                             | None                        |
| 0                            | 0                              | 1                  | $\geq 17$                      | MSB is TAG bit plus zero(s) |
| 0                            | 1                              | 0                  | 12                             | None                        |
| 0                            | 1                              | 1                  | $\geq 17$                      | TAG bit plus seven zeros    |
| 1                            | 0                              | 0                  | 16                             | None                        |
| 1                            | 0                              | 1                  | 24                             | TAG bit plus seven zeros    |
| 1                            | 1                              | 0                  | 16                             | None                        |
| 1                            | 1                              | 1                  | 24                             | TAG bit plus seven zeros    |

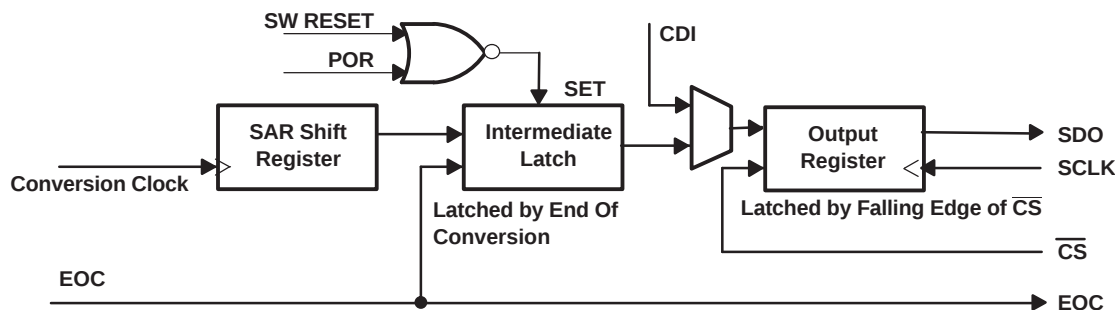
SCLK skew between converters and data path delay through the converters configured in chain mode can affect the maximum frequency of SCLK. The delay can also be affected by supply voltage and loading. It may be necessary to slow down the SCLK when the devices are configured in chain mode. Figure 65 shows a typical delay process through multiple converters linked in daisy-chain mode.



**Figure 65. Typical Delay Through Converters Configured in Chain Mode**

## RESET

The converter has two reset mechanisms: a power-on reset (POR) and a software reset using CFR\_D0. These two mechanisms are NOR-ed internally. When a reset (software or POR) is issued, all register data are set to the default values (all 1s) and the SDO output (during the cycle immediately after reset) is set to all 1s. The state machine is reset to the power-on state. Figure 66 illustrates the digital output under a reset condition.



**Figure 66. Digital Output Under Reset Condition**

When the device is powered up, the POR sets the device to default mode when AVDD reaches 1.5V. When the device is powered down, the POR circuit requires AVDD to remain below 125mV for at least 350ms to ensure proper discharging of internal capacitors and to correct the behavior of the ADC when powered up again. If AVDD drops below 400mV but remains above 125mV, the internal POR capacitor does not discharge fully and the device requires a software reset to perform correctly after the recovery of AVDD (this condition is shown as the *undefined zone* in Figure 67).

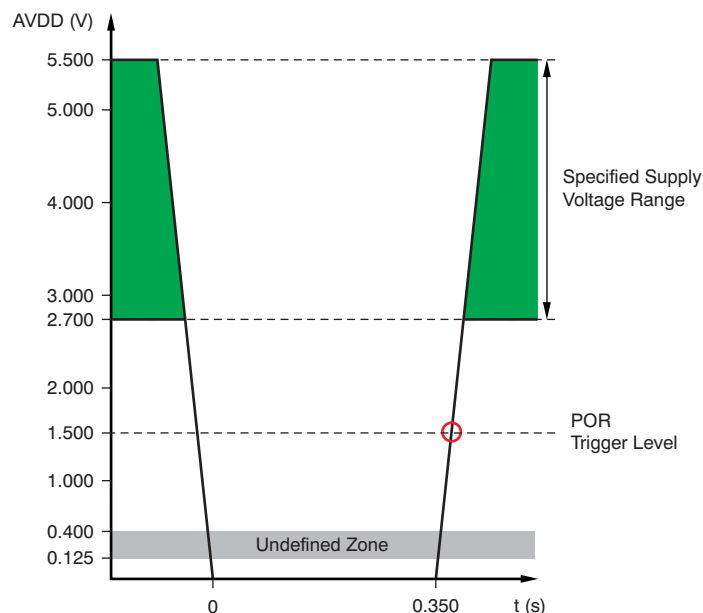
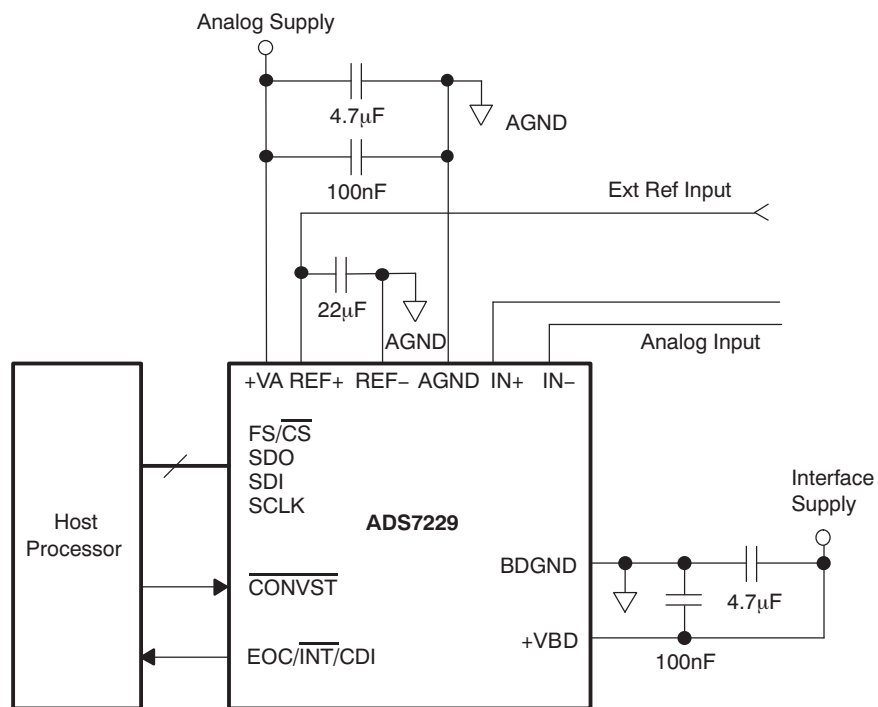


Figure 67. Relevant Voltage Levels for POR

## APPLICATION INFORMATION

### TYPICAL CONNECTION

Figure 68 shows a typical circuit configuration for the device.



**Figure 68. Typical Circuit Configuration**

## Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| Changes from Original (May 2008) to Revision A                                                                                                                                                | Page |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|
| • Added +REF to AGND and –REF to AGND specifications to Voltage range section of <i>Absolute Maximum Ratings</i> table .                                                                      | 2    |
| • Changed Revised conditions of the 5V <i>Electrical Characteristics</i> to +VA = 4.5V to 5.5V .....                                                                                          | 3    |
| • Changed Revised conditions of the 5V <i>Electrical Characteristics</i> to +VA = 4.5V to 5.5V .....                                                                                          | 4    |
| • Deleted typical specification from Input reference range, $V_{REF} [(REF+) - (REF-)]$ row of the External Voltage Reference Input section of the 5V <i>Electrical Characteristics</i> ..... | 4    |
| • Changed test condition of Supply current, <i>PD mode</i> to <i>Deep power-down mode</i> in Power-Supply Requirements section of the 5V <i>Electrical Characteristics</i> .....              | 4    |
| • Changed $V_{REF}$ row of External Voltage Reference Input section in the 2.5V <i>Electrical Characteristics</i> .....                                                                       | 6    |
| • Changed test condition of Supply current, <i>PD mode</i> to <i>Deep power-down mode</i> in Power-Supply Requirements section of the 2.5V <i>Electrical Characteristics</i> .....            | 7    |
| • Corrected typo in <a href="#">Figure 2</a> .....                                                                                                                                            | 12   |
| • Corrected typo in <a href="#">Figure 3</a> .....                                                                                                                                            | 13   |
| • Corrected typo in <a href="#">Figure 5</a> .....                                                                                                                                            | 14   |
| • Added last sentence to the <i>Driver Amplifier Choice</i> section.....                                                                                                                      | 24   |
| • Updated <a href="#">Figure 54</a> .....                                                                                                                                                     | 24   |
| • Updated <a href="#">Figure 55</a> .....                                                                                                                                                     | 24   |
| • Changed fifth sentence of the <i>Deep Power-Down Mode</i> section.....                                                                                                                      | 27   |
| • Changed <i>Supply Current</i> specification of Auto nap power-down row of <a href="#">Table 2</a> .....                                                                                     | 28   |
| • Added <a href="#">Figure 67</a> and corresponding paragraph to the <i>RESET</i> section .....                                                                                               | 38   |

## PACKAGING INFORMATION

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)            | Lead/Ball Finish<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|----------------------------|-------------------------|----------------------|--------------|-------------------------|-------------------------|
| ADS7229IPW       | ACTIVE        | TSSOP        | PW                 | 16   | 90             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-2-260C-1 YEAR  | -40 to 85    | ADS<br>7229I A          | <a href="#">Samples</a> |
| ADS7229IPWG4     | ACTIVE        | TSSOP        | PW                 | 16   | 90             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-2-260C-1 YEAR  | -40 to 85    | ADS<br>7229I A          | <a href="#">Samples</a> |
| ADS7229IPWR      | ACTIVE        | TSSOP        | PW                 | 16   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-2-260C-1 YEAR  | -40 to 85    | ADS<br>7229I A          | <a href="#">Samples</a> |
| ADS7229IPWRG4    | ACTIVE        | TSSOP        | PW                 | 16   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-2-260C-1 YEAR  | -40 to 85    | ADS<br>7229I A          | <a href="#">Samples</a> |
| ADS7229IRSAR     | ACTIVE        | QFN          | RSA                | 16   | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-2-260C-1 YEAR  | -40 to 85    | ADS<br>7229I A          | <a href="#">Samples</a> |
| ADS7229IRSAT     | ACTIVE        | QFN          | RSA                | 16   | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-2-260C-1 YEAR  | -40 to 85    | ADS<br>7229I A          | <a href="#">Samples</a> |
| ADS7229IRSATG4   | ACTIVE        | QFN          | RSA                | 16   | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-2-260C-1 YEAR  | -40 to 85    | ADS<br>7229I A          | <a href="#">Samples</a> |
| ADS7230IPW       | ACTIVE        | TSSOP        | PW                 | 16   | 90             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-2-260C-1 YEAR  | -40 to 85    | ADS<br>7230I A          | <a href="#">Samples</a> |
| ADS7230IPWG4     | ACTIVE        | TSSOP        | PW                 | 16   | 90             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-2-260C-1 YEAR  | -40 to 85    | ADS<br>7230I A          | <a href="#">Samples</a> |
| ADS7230IPWR      | ACTIVE        | TSSOP        | PW                 | 16   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-2-260C-1 YEAR  | -40 to 85    | ADS<br>7230I A          | <a href="#">Samples</a> |
| ADS7230IRSAR     | ACTIVE        | QFN          | RSA                | 16   | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-2-260C-1 YEAR  | -40 to 85    | ADS<br>7230I A          | <a href="#">Samples</a> |
| ADS7230IRSAT     | ACTIVE        | QFN          | RSA                | 16   | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-2-260C-1 YEAR  | -40 to 85    | ADS<br>7230I A          | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

---

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "-" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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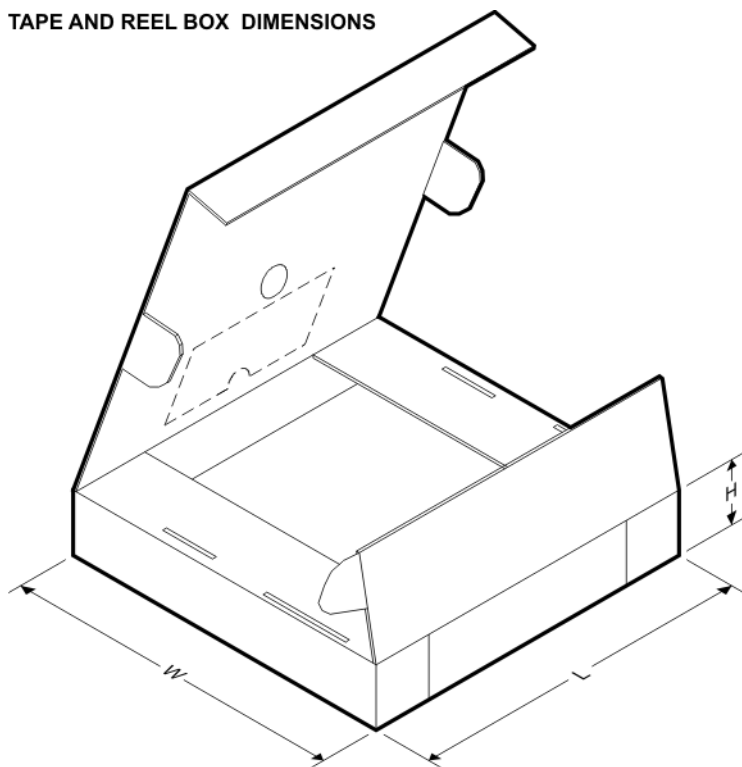
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**TAPE AND REEL INFORMATION**


\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| ADS7229IPWR  | TSSOP        | PW              | 16   | 2000 | 330.0              | 12.4               | 6.9     | 5.6     | 1.6     | 8.0     | 12.0   | Q1            |
| ADS7229IRSAR | QFN          | RSA             | 16   | 3000 | 330.0              | 12.4               | 4.3     | 4.3     | 1.5     | 8.0     | 12.0   | Q2            |
| ADS7229IRSAT | QFN          | RSA             | 16   | 250  | 180.0              | 12.4               | 4.3     | 4.3     | 1.5     | 8.0     | 12.0   | Q2            |
| ADS7230IPWR  | TSSOP        | PW              | 16   | 2000 | 330.0              | 12.4               | 6.9     | 5.6     | 1.6     | 8.0     | 12.0   | Q1            |
| ADS7230IRSAR | QFN          | RSA             | 16   | 3000 | 330.0              | 12.4               | 4.3     | 4.3     | 1.5     | 8.0     | 12.0   | Q2            |
| ADS7230IRSAT | QFN          | RSA             | 16   | 250  | 180.0              | 12.4               | 4.3     | 4.3     | 1.5     | 8.0     | 12.0   | Q2            |

## TAPE AND REEL BOX DIMENSIONS

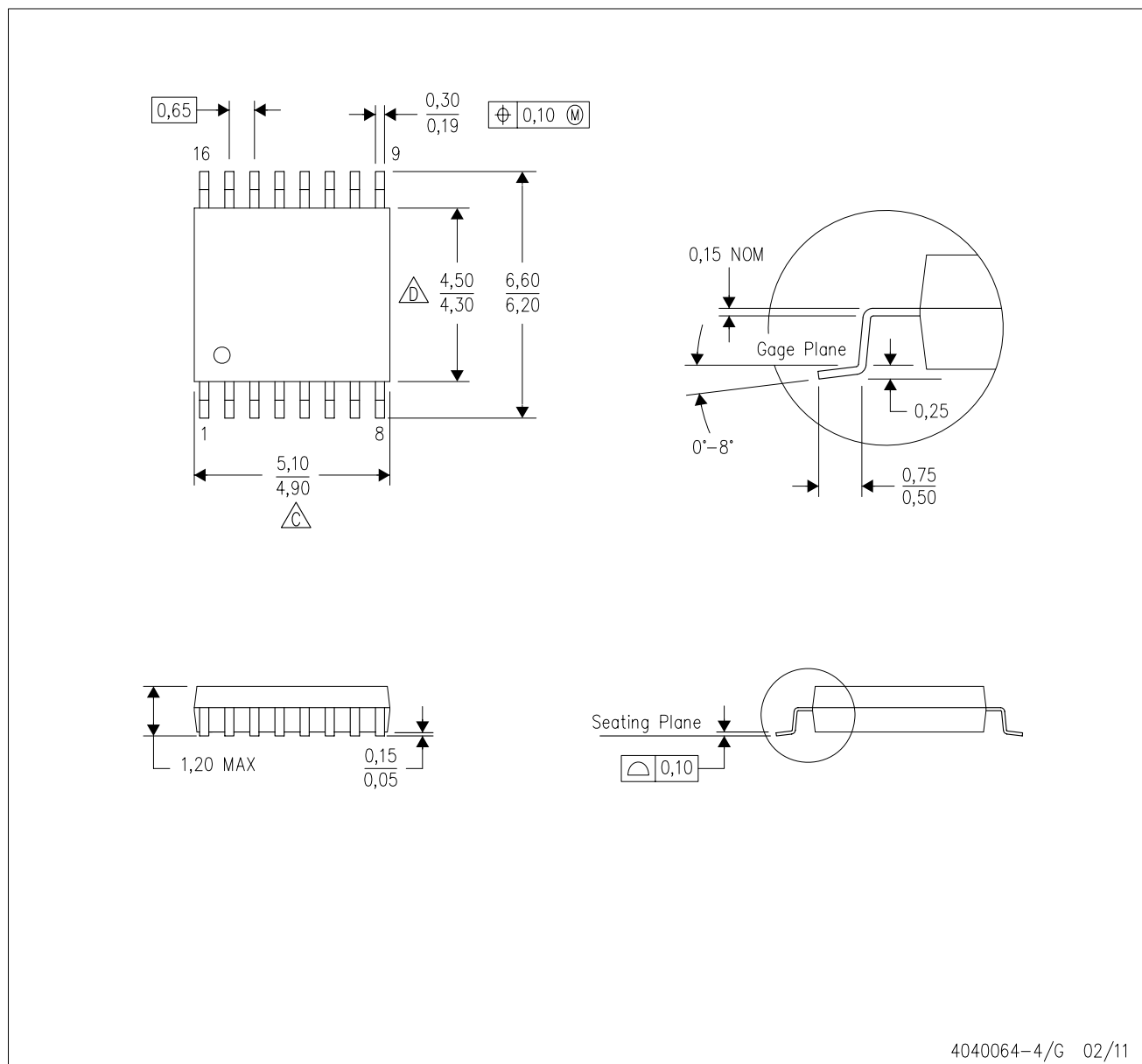


\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| ADS7229IPWR  | TSSOP        | PW              | 16   | 2000 | 367.0       | 367.0      | 35.0        |
| ADS7229IRSAR | QFN          | RSA             | 16   | 3000 | 338.1       | 338.1      | 20.6        |
| ADS7229IRSAT | QFN          | RSA             | 16   | 250  | 210.0       | 185.0      | 35.0        |
| ADS7230IPWR  | TSSOP        | PW              | 16   | 2000 | 367.0       | 367.0      | 35.0        |
| ADS7230IRSAR | QFN          | RSA             | 16   | 3000 | 338.1       | 338.1      | 20.6        |
| ADS7230IRSAT | QFN          | RSA             | 16   | 250  | 210.0       | 185.0      | 35.0        |

PW (R-PDSO-G16)

PLASTIC SMALL OUTLINE

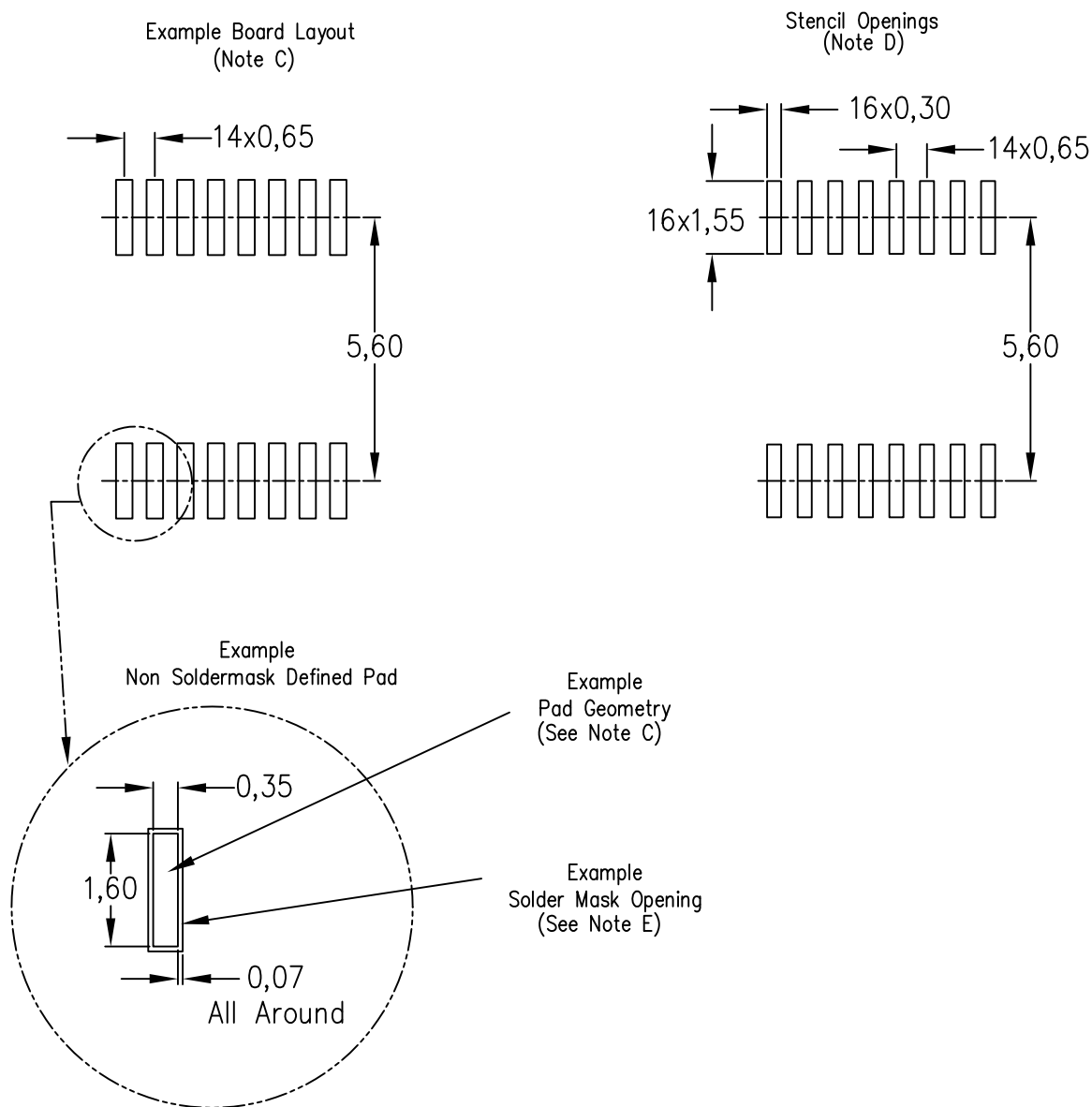


4040064-4/G 02/11

- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.
  - D. Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.
  - E. Falls within JEDEC MO-153

PW (R-PDSO-G16)

PLASTIC SMALL OUTLINE

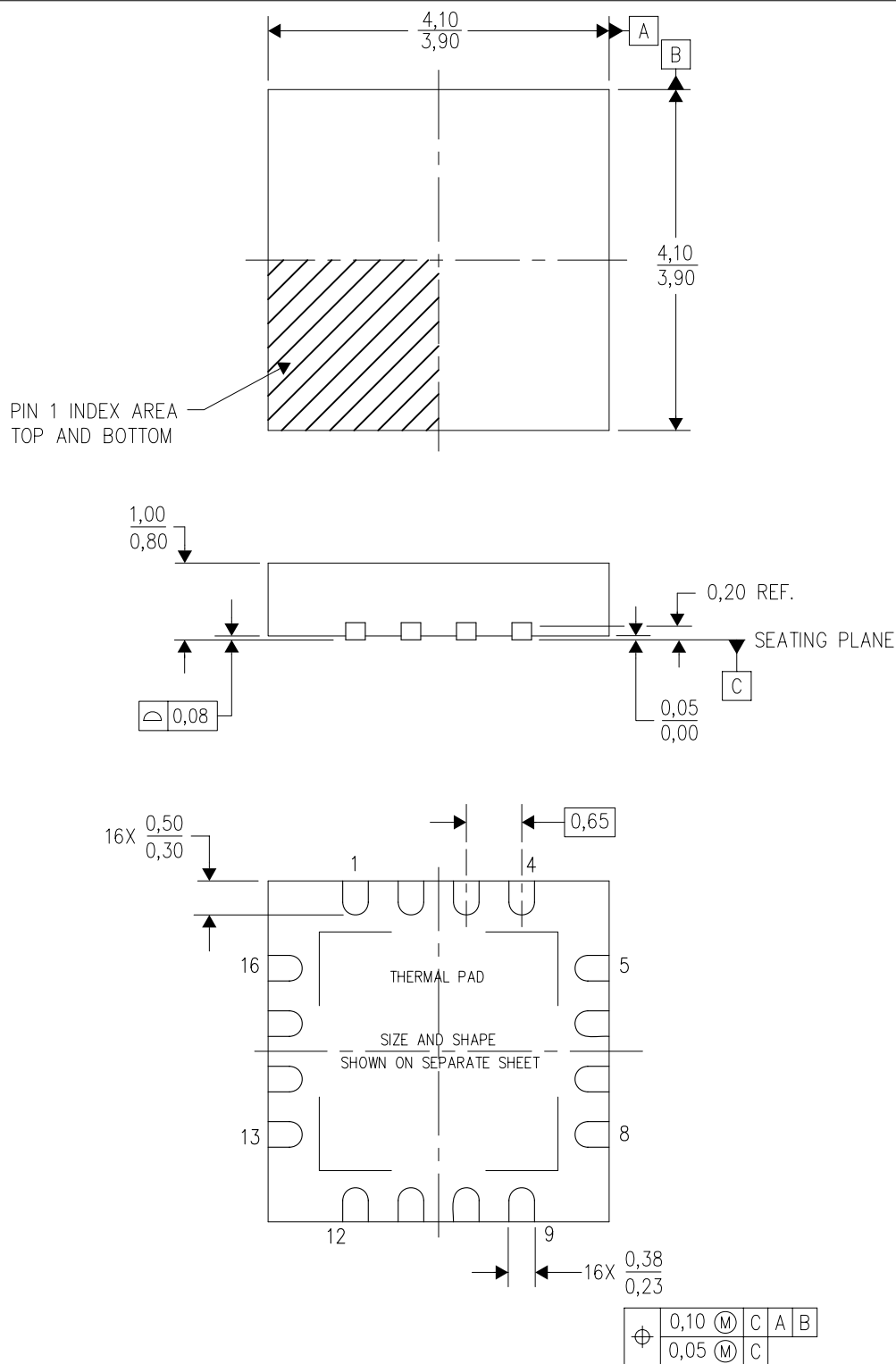


4211284-3/F 12/12

- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Publication IPC-7351 is recommended for alternate designs.
  - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

RSA (S-PVQFN-N16)

PLASTIC QUAD FLATPACK NO-LEAD



4205141/D 06/11

- NOTES:
- All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - This drawing is subject to change without notice.
  - Quad Flatpack, No-leads (QFN) package configuration.
  - The package thermal pad must be soldered to the board for thermal and mechanical performance.
  - See the additional figure in the Product Data Sheet for details regarding the exposed thermal pad features and dimensions.
  - Falls within JEDEC MO-220.

RSA (S-PVQFN-N16)

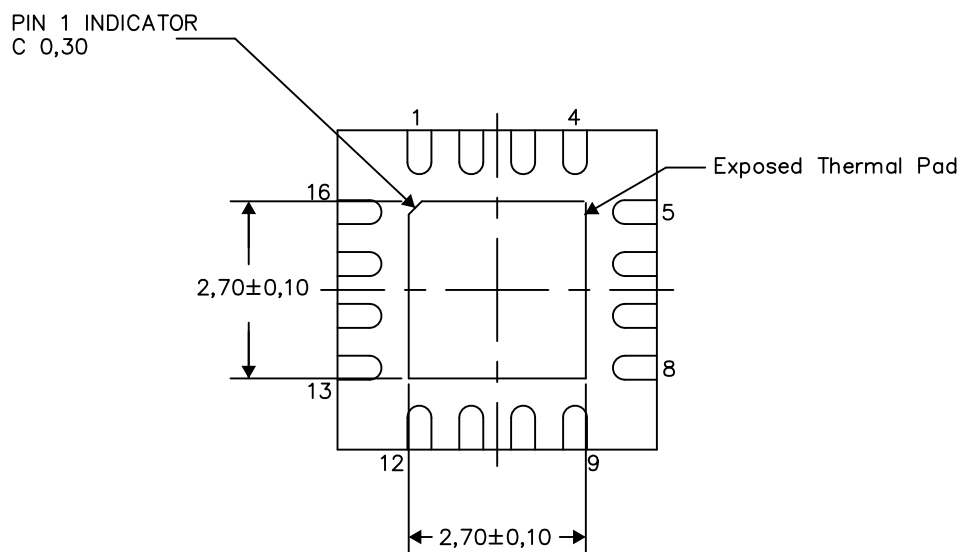
PLASTIC QUAD FLATPACK NO-LEAD

## THERMAL INFORMATION

This package incorporates an exposed thermal pad that is designed to be attached directly to an external heatsink. The thermal pad must be soldered directly to the printed circuit board (PCB). After soldering, the PCB can be used as a heatsink. In addition, through the use of thermal vias, the thermal pad can be attached directly to the appropriate copper plane shown in the electrical schematic for the device, or alternatively, can be attached to a special heatsink structure designed into the PCB. This design optimizes the heat transfer from the integrated circuit (IC).

For information on the Quad Flatpack No-Lead (QFN) package and its advantages, refer to Application Report, QFN/SON PCB Attachment, Texas Instruments Literature No. SLUA271. This document is available at [www.ti.com](http://www.ti.com).

The exposed thermal pad dimensions for this package are shown in the following illustration.



Bottom View

Exposed Thermal Pad Dimensions

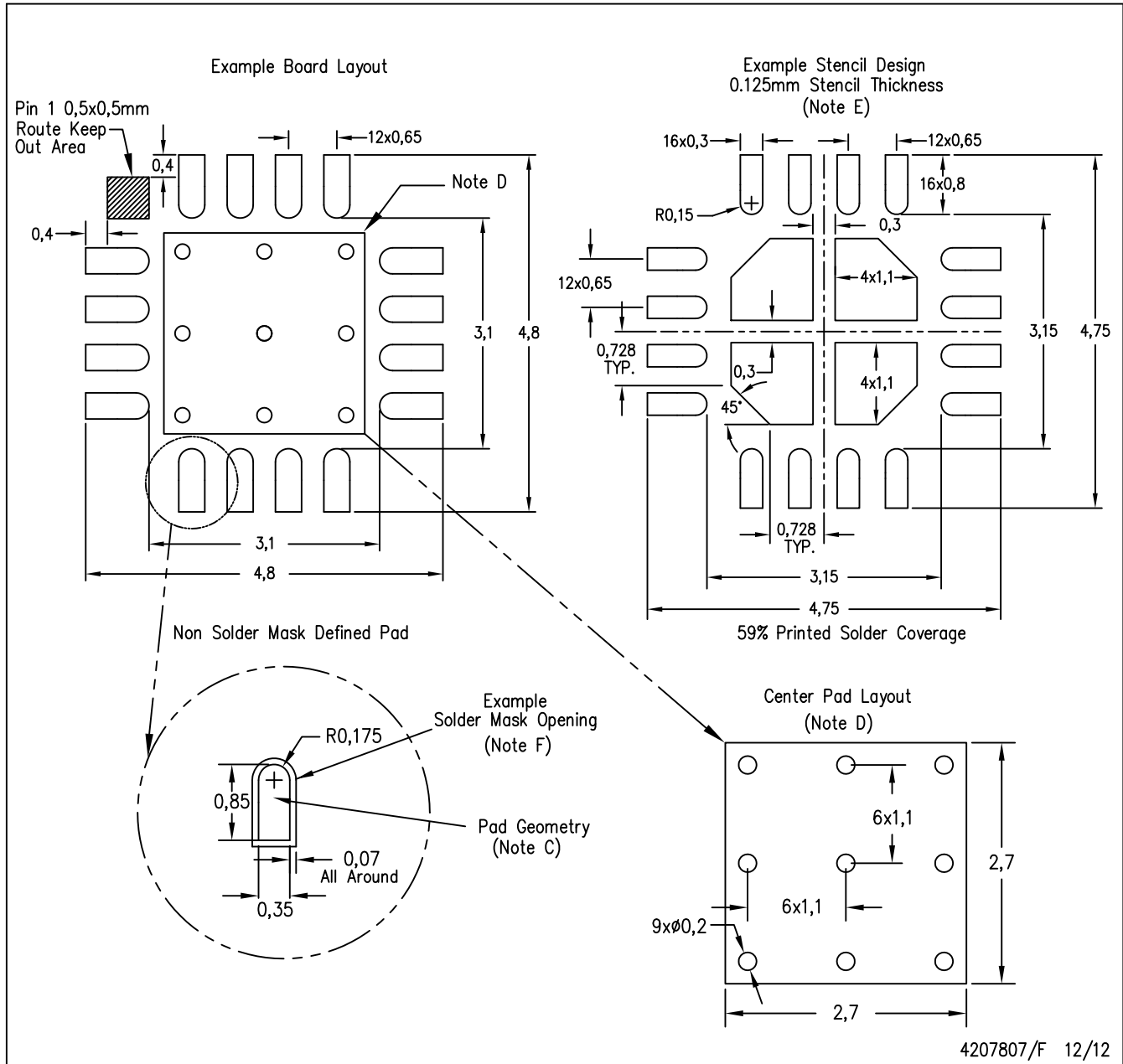
4206364/N 07/13

## NOTES:

A. All linear dimensions are in millimeters

RSA (S-PVQFN-N16)

PLASTIC QUAD FLATPACK NO-LEAD



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Publication IPC-7351 is recommended for alternate designs.
  - D. This package is designed to be soldered to a thermal pad on the board. Refer to Application Note, QFN Packages, Texas Instruments Literature No. SLUA271, and also the Product Data Sheets for specific thermal information, via requirements, and recommended board layout. These documents are available at [www.ti.com](http://www.ti.com) <<http://www.ti.com>>.
  - E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC 7525 for stencil design considerations.
  - F. Customers should contact their board fabrication site for solder mask tolerances.

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